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To: _____

SPECIFICATIONS

Product Type Timing IC (Low Power 270K/320K pixels CCD)

Model No. LR38277

※This specifications contains 43 pages including the cover and appendix.
If you have any objections, please contact us before issuing purchasing order.

CUSTOMERS ACCEPTANCE

DATE: _____

BY: _____

PRESENTED

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PREPARED BY:

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 - Instrumentation and measuring equipment
 - Machine tools
 - Audiovisual equipment
 - Home appliances
 - Communication equipment other than for trunk lines
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 - Mainframe computers
 - Traffic control systems
 - Gas leak detectors and automatic cutoff devices
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 - Medical equipment related to life support, etc.
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- Please direct all queries regarding the products covered herein to a sales representative of the company.

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1. General

The LR38277 is a CMOS gate array LSI. It generates timing pulses for driving CCD area sensor, and signals and processing pulses for video signals.

1-1. Features

- * The package material is plastic.
- * A p-type silicon circuit board is used.
- * The package type is 48-pin QFP (0.5mm pin-pitch)
- * The process (structure) is CMOS.
- * The delay time per 1 gate is 0.4ns.
- * Not designed or rated as radiation hardened.

1-2. Functions

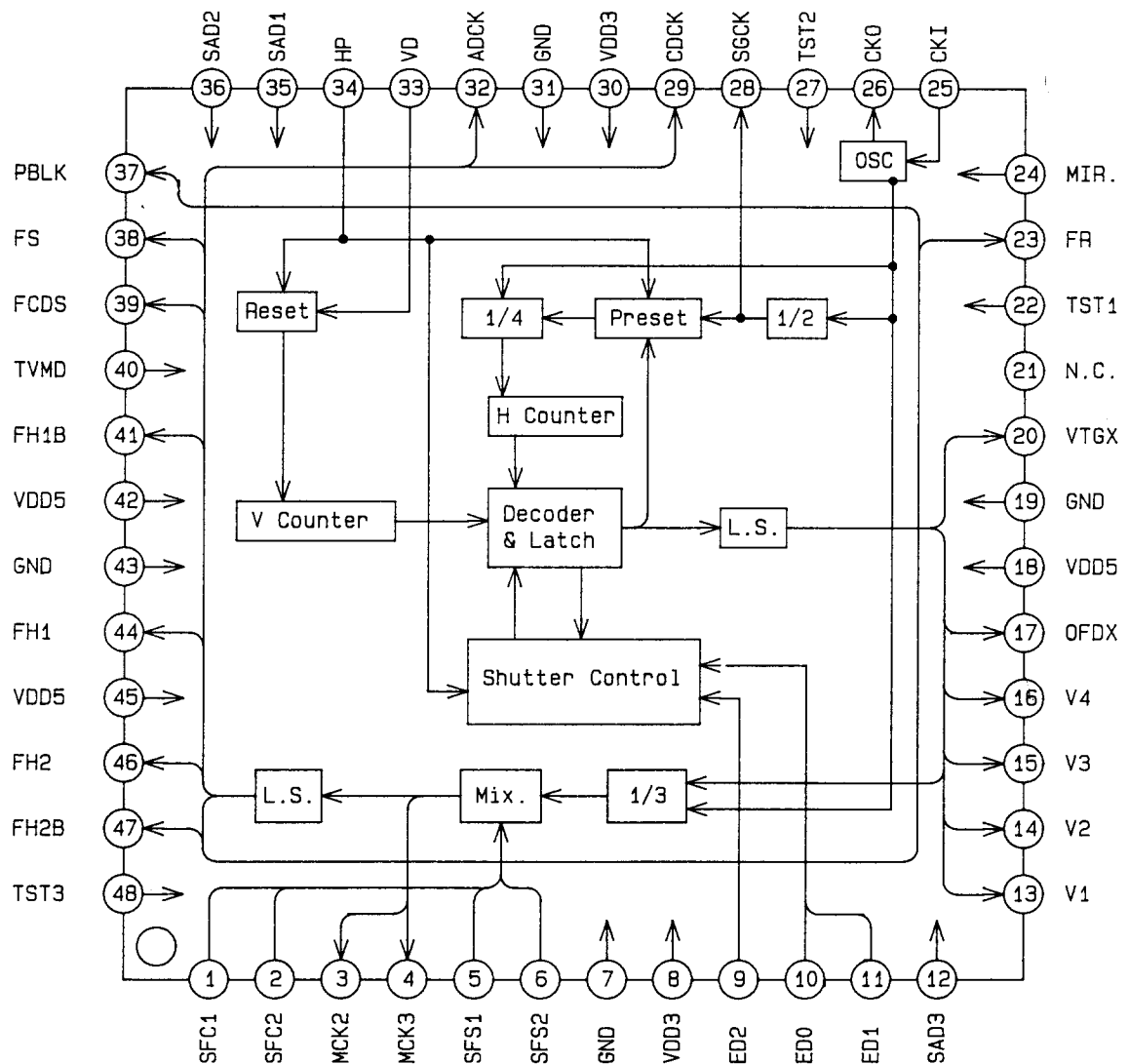
- * Designed for Two-Power Supply CCD color area sensor with 270,000 or 320,000 pixels using with DSP-IC (LR38263).
- * Switchable between NTSC and PAL mode.
- * Mirror image control function is possible.
- * +3.3V and +5V power supply.
- * External shutter control function with serial data input is possible.

2. Pin Assignment

PIN NO.	I / O	SIGNAL	PIN NO.	I / O	SIGNAL
1	I C 3	S F C 1	25	O S C I 3	C K I
2	I C 3	S F C 2	26	O S C O 3	C K O
3	O 6 M A 3 2	M C K 2	27	I C D 3	T S T 2
4	O 6 M A 3 2	M C K 3	28	O 6 M A 3 2	S G C K
5	I C 3	S F S 1	29	O 6 M A 3 2	C D C K
6	I C 3	S F S 2	30	—	V D D 3
7	—	G N D	31	—	G N D
8	—	V D D 3	32	O 6 M A 3 2	A D C K
9	I C D 3	E D 2	33	I C 3	V D
10	I C D 3	E D 0	34	I C 3	H P
11	I C D 3	E D 1	35	I C U 3	S A D 1
12	I C U 5	S A D 3	36	I C U 5	S A D 2
13	O 6 M A 5 2	V 1	37	O 5	P B L K
14	O 6 M A 5 2	V 2	38	O 6 M A 5	F S
15	O 6 M A 5 2	V 3	39	O 6 M A 5	F C D S
16	O 6 M A 5 2	V 4	40	I C U 5	T V M D
17	O 6 M A 5	O F D X	41	O 6 M A 5 2	F H 1 B
18	—	V D D 5	42	—	V D D 5
19	—	G N D	43	—	G N D
20	O 6 M A 5	V T G X	44	O 6 M A 5 2	F H 1
21	—	N. C.	45	—	V D D 5
22	I C D 5	T S T 1	46	O 6 M A 5 2	F H 2
23	O 6 M A 5 2	F R	47	O 6 M A 5 2	F H 2 B
24	I C D 3	M I R	48	I C D 3	T S T 3

I C 3 : Input (CMOS level)
 I C U 3 : Input (CMOS level with pull-up resister)
 I C D 3 : Input (CMOS level with pull-down resister)
 I C U 5 : Input (CMOS level with pull-up resister)
 I C D 5 : Input (CMOS level with pull-down resister)
 O 6 M A 5 : Output
 O 6 M A 5 2 : Output
 O 6 M A 3 2 : Output
 O S C I 3 : Input pin for oscillation
 O S C O 3 : Output pin for oscillation

3. Block Diagram



4. Pin Description

No.	Symbol	I/O	Pol.	Pin Name	Description
1	SFC1	IC3	—	FCDS phase control input 1	An input pin to set the rising edge of FCDS(pin39) pulse output. To be connected to the signal from MCK2(pin3) output through the RC integral circuit.
2	SFC2	IC3	—	FCDS phase control input 2	An input pin to set the falling phase of FCDS(pin 39) pulse output. To be connected to the signal from MCK3(pin4) output through the RC integral circuit.
4	MCK2	06MA 32		Clock output 2	A pin to output 1/2 dividing pulse of reference clock CKI(pin 25). It is the same phase with FH1 (pin 44).
5	MCK3	06MA 32		Clock output 3	A pin to output 1/2 dividing pulse of reference clock CKI(pin 25). It is delayed by approximately 90° in phase with respect MCK2(pin 3).
5	SFS1	IC3	—	FS phase control input 1	An input pin to set the rising edge of FS(pin 38) pulse output. To be connected to the signal from MCK2(pin 4) output through the RC integral circuit.
6	SFS2	IC3	—	FS phase control input 2	An input pin to set the falling edge of FS(pin 38) pulse output. To be connected to the signal from MCK3(pin 5) output through the RC integral circuit.
7	GND	—	—	Ground	A grounding pin.
8	VDD3	—	—	Power supply	Supply +3.3V power.
9	ED2	ICD3	—	Strobe pulse input	An input pin for the strobe pulse to control the shutter speed. For details, see shutter control.
10	ED0	ICD3	—	Sift register Clock input	An input pin for the clock of shift register to control the shutter speed. For details, see shutter control.
11	ED1	ICD3	—	Serial Shutter Data input	An input pin for the data of serial shutter code to control the shutter speed. For details, see shutter control.
12	SAD3	ICU5	—	ADCK phase control input	Pins to control the phase of ADCK.
13	V1	06MA 52		Ver. transfer pulse output #1	A vertical transfer pulse for CCD. To be connected to φV1 pin of CCD.
14	V2	06MA 52		Ver. transfer pulse output #1	A vertical transfer pulse for CCD. To be connected to φV2 pin of CCD.
15	V3	06MA 52		Ver. transfer pulse output #3	A vertical transfer pulse for CCD. To be connected to φV3 pin of CCD.
16	V4	06MA 52		Ver. transfer pulse output #4	A vertical transfer pulse for CCD. To be connected to φV4 pin of CCD.

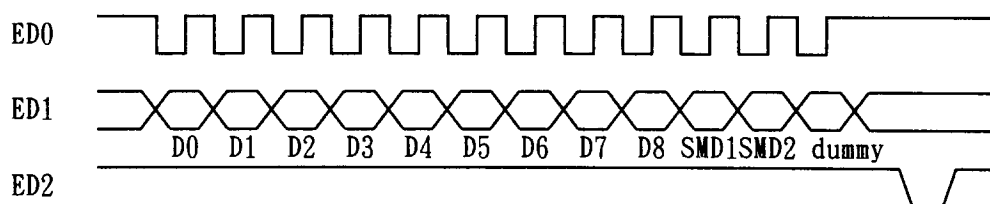
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No.	Symbol	I/O	Pol.	Pin Name	Description									
17	OFDX	06MA5		Electronic shutter pulse output 1	A pulse that sweeps the charge of the photodiode for electrical shutter. Connect to OFD of CCD through the invert, level shift and DC offset circuit. Held at H level at normal mode.									
18	VDD5	-	-	Power supply	Supply +5 V power.									
19	GND	-	-	Ground	A grounding pin.									
20	VTGX	06MA5		Read-out pulse output	A pulse that transfers the charge of the photodiode to the vertical shift resister. Connect to VTG pin of CCD through the invert and level shift.									
21	NC	-	-	(No-connect)	Non-connection.									
22	TST1	ICD5	-	Test terminal 1	A test pin. Set open or to L level in the normal mode.									
23	FR	06MA52		Reset pulse output	A reset pulse for CCD. To be connected to ϕR of CCD through the D.C. offset circuit.									
24	NC	-	-	(No-connect)	Non-connection.									
25	CKI	OSCI3		Clock input	An input pin for reference clock oscillation. The frequencies are as follows : at NTSC mode : 28.63636MHz (1820fH) at PAL mode : 28.37500MHz (1816fH) fH=Hor. frequency									
26	CKO	OSCO3		Clock output	An output pin for reference clock oscillation. The output is the inverse CKI(pin 25).									
27	TST2	ICD3	-	Test terminal 2	A test pin. Set open or to L level in the normal mode.									
28	SGCK	06MA32	-	SSG clock output	A pulse for clock of SSG circuit. The frequencies are as follows : at NTSC mode : 14.31818MHz (910fH) at CCIR mode : 14.18750MHz (908fH)									
29	CDCK	06MA32	-	DSP clock output	A pulse for clock of DSP-IC. The frequencies are as follows : <table><tr><td>SCCD</td><td>L</td><td>H or open</td></tr><tr><td>NTSC mode</td><td>9.5035MHz (1820/3fH)</td><td>14.31818MHz (910fH)</td></tr><tr><td>PAL mode</td><td>9.4375MHz (1816/3fH)</td><td>14.18750MHz (908fH)</td></tr></table>	SCCD	L	H or open	NTSC mode	9.5035MHz (1820/3fH)	14.31818MHz (910fH)	PAL mode	9.4375MHz (1816/3fH)	14.18750MHz (908fH)
SCCD	L	H or open												
NTSC mode	9.5035MHz (1820/3fH)	14.31818MHz (910fH)												
PAL mode	9.4375MHz (1816/3fH)	14.18750MHz (908fH)												
30	VDD3	-	-	Power supply	Supply +5 V power.									
31	GND	-	-	Ground	A grounding pin.									

No.	Symbol	I/O	Pol.	Pin Name	Description																												
32	ADCK	06MA 32	—	AD clock output	A pulse for clock of A/D converter. The frequencies are as follows : NTSC mode; 9.5035MHz (1820/3fH) PAL mode ; 9.4375MHz (1816/3fH) The phase of ADCK is selected by SAD1(pin35), SAD2(pin36) and SAD3(pin12).																												
33	VD	IC3		Ver. drive pulse	An input pin for the Vertical reference signal. To be connected to the DSP-IC.																												
34	HP	IC3		Hor. drive pulse	An input pin for the Horizontal reference signal. To be connected to the DSP-IC.																												
35	SAD1	ICU3	—	ADCK phase control input	Pins to control the phase of ADCK. <table><tr><td>SAD1</td><td>SAD2</td><td>SAD3</td><td>ADCK</td></tr><tr><td>L</td><td>L</td><td>L</td><td>0°</td></tr><tr><td>H</td><td>L</td><td>L</td><td>delayed 60°</td></tr><tr><td>L</td><td>H</td><td>L</td><td>delayed 120°</td></tr><tr><td>H</td><td>H</td><td>L</td><td>delayed 180°</td></tr><tr><td>L</td><td>L</td><td>H</td><td>delayed 240°</td></tr><tr><td>H</td><td>L</td><td>H</td><td>delayed 300°</td></tr></table>	SAD1	SAD2	SAD3	ADCK	L	L	L	0°	H	L	L	delayed 60°	L	H	L	delayed 120°	H	H	L	delayed 180°	L	L	H	delayed 240°	H	L	H	delayed 300°
SAD1	SAD2	SAD3	ADCK																														
L	L	L	0°																														
H	L	L	delayed 60°																														
L	H	L	delayed 120°																														
H	H	L	delayed 180°																														
L	L	H	delayed 240°																														
H	L	H	delayed 300°																														
36	SAD2	ICU5	—																														
37	PBLK	05		Pre-blanking pulse output	A pulse that correspondes to the cease period of the horizontal transfer pulse.																												
38	FS	06MA5		CDS pulse 2	A pulse to sample-hold the signal from CCD. Generated by SFS1(pin 5) and SFS2(pin 6).																												
39	FCDS	06MA5		CDS pulse 1	A pulse to clamp the feed-through level from CCD. Generated by SFC1(pin 1) and SFC2(pin 2).																												
40	TVMD	ICU5	—	TV mode select	An input pin to select TV standards. L level ; NTSC mode H level or open : PAL mode																												
41	FH1B	06MA 52		Hor. transfer pulse 1B	A horizontal transfer pulse for CCD. To be connected to φH1B of CCD.																												
42	VDD5	—	—	Power supply	Supply +5 V power.																												
43	GND	—	—	Ground	A grounding pin.																												
44	FH1	06MA 52		Hor. transfer pulse 1	A horizontal transfer pulse for CCD. To be connected to φH1 of CCD.																												
45	VDD5	—	—	Power supply	Supply +5 V power.																												
46	FH2	06MA 52		Hor. transfer pulse 2	A horizontal transfer pulse for CCD. To be connected to φH2 of CCD.																												
46	FH2B	06MA 52		Hor. transfer pulse 2B	A horizontal transfer pulse for CCD. To be connected to φH2B of CCD.																												
48	TST3	ICD3	—	Test terminal 3	A test pin. Set open or to L level in the normal mode.																												

4-2. Shutter Speed Contorol.

(1) Timing of Serial Data input



The data of shutter speed is latched by the rising edge of HP, wich horizontal line number is in VTGX output.

(2) Table of the serial shutter data

Serial Data												n	Exposure Period(H)	
D0	D1	D2	D3	D4	D5	D6	D7	D8	SMD1	SMD2	dummy		NTSC	PAL
×	×	×	×	×	×	×	×	×	H	H	×	—	262H, 263H	312H, 312H
×	×	×	×	×	×	×	×	×	L	L	×	—	157H+A	260H+B
×	×	×	×	×	×	×	×	×	H	L	×	—	INHIBIT	INHIBIT
L	L	L	L	L	L	L	L	L	L	H	×	—	INHIBIT	INHIBIT
H	L	L	L	L	L	L	L	L	L	H	×	1	261H+A	311H+B
L	H	L	L	L	L	L	L	L	L	H	×	2	260H+A	310H+B
H	H	L	L	L	L	L	L	L	L	H	×	3	259H+A	309H+B
L	L	H	L	L	L	L	L	L	L	H	×	4	258H+A	308H+B
H	L	H	L	L	L	L	L	L	L	H	×	5	257H+A	307H+B
L	H	H	L	L	L	L	L	L	L	H	×	6	256H+A	306H+B
H	H	H	L	L	L	L	L	L	L	H	×	7	255H+A	305H+B
L	L	L	H	L	L	L	L	L	L	H	×	8	254H+A	304H+B
H	L	L	H	L	L	L	L	L	L	H	×	9	253H+A	303H+B
L	H	L	H	L	L	L	L	L	L	H	×	10	252H+A	302H+B
H	H	L	H	L	L	L	L	L	L	H	×	11	251H+A	301H+B
L	L	H	H	L	L	L	L	L	L	H	×	12	250H+A	300H+B
H	L	H	H	L	L	L	L	L	L	H	×	13	249H+A	299H+B
L	H	H	H	L	L	L	L	L	L	H	×	14	248H+A	298H+B
H	H	H	H	L	L	L	L	L	L	H	×	15	247H+A	297H+B
L	L	L	L	H	L	L	L	L	L	H	×	16	246H+A	296H+B
H	L	L	L	H	L	L	L	L	L	H	×	17	245H+A	295H+B
∅	∅	∅	∅	∅	∅	∅	∅	∅	L	H	×	∅	∅	∅
L	L	H	L	H	H	H	H	L	L	H	×	244	18H+A	68H+B
H	L	H	L	H	H	H	H	L	L	H	×	245	17H+A	67H+B
L	H	H	L	H	H	H	H	L	L	H	×	246	16H+A	66H+B
H	H	H	L	H	H	H	H	L	L	H	×	247	15H+A	65H+B
L	L	L	H	H	H	H	H	L	L	H	×	248	14H+A	64H+B
H	L	L	H	H	H	H	H	L	L	H	×	249	13H+A	63H+B
L	H	L	H	H	H	H	H	L	L	H	×	250	12H+A	62H+B
H	H	L	H	H	H	H	H	L	L	H	×	251	11H+A	61H+B
L	L	H	H	H	H	H	H	L	L	H	×	252	10H+A	60H+B
H	L	H	H	H	H	H	H	L	L	H	×	253	9H+A	59H+B

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Serial Data												n	Exposure Period(H)	
D0	D1	D2	D3	D4	D5	D6	D7	D8	SMD1	SMD2	dummy		NTSC	PAL
L	H	H	H	H	H	H	H	L	L	H	×	254	8H+A	58H+B
H	H	H	H	H	H	H	H	L	L	H	×	255	7H+A	57H+B
L	L	L	L	L	L	L	L	H	L	H	×	256	6.85H	56H+B
H	L	L	L	L	L	L	L	H	L	H	×	257	6H+A	55H+B
L	H	L	L	L	L	L	L	H	L	H	×	258	5.85H	54H+B
H	H	L	L	L	L	L	L	H	L	H	×	259	5H+A	53H+B
L	L	H	L	L	L	L	L	H	L	H	×	260	4.85H	52H+B
H	L	H	L	L	L	L	L	H	L	H	×	261	4H+A	51H+B
L	H	H	L	L	L	L	L	H	L	H	×	262	4.01H	50H+B
H	H	H	L	L	L	L	L	H	L	H	×	263	3.67H	49H+B
L	L	L	H	L	L	L	L	H	L	H	×	264	3H+A	48H+B
H	L	L	H	L	L	L	L	H	L	H	×	265	3.01H	47H+B
L	H	L	H	L	L	L	L	H	L	H	×	266	2.67H	46H+B
H	H	L	H	L	L	L	L	H	L	H	×	267	2H+A	45H+B
L	L	H	H	L	L	L	L	H	L	H	×	268	2.16H	44H+B
H	L	H	H	L	L	L	L	H	L	H	×	269	1.95H	43H+B
L	H	H	H	L	L	L	L	H	L	H	×	270	1.74H	42H+B
H	H	H	H	L	L	L	L	H	L	H	×	271	1.55H	41H+B
L	L	L	L	H	L	L	L	H	L	H	×	272	1H+A	40H+B
H	L	L	L	H	L	L	L	H	L	H	×	273	1.20H	39H+B
L	H	L	L	H	L	L	L	H	L	H	×	274	1.05H	38H+B
H	H	L	L	H	L	L	L	H	L	H	×	275	0.92H	37H+B
L	L	H	L	H	L	L	L	H	L	H	×	276	0.80H	36H+B
H	L	H	L	H	L	L	L	H	L	H	×	277	0.70H	35H+B
L	H	H	L	H	L	L	L	H	L	H	×	278	0.61H	34H+B
H	H	H	L	H	L	L	L	H	L	H	×	279	0.54H	33H+B
L	L	L	H	H	L	L	L	H	L	H	×	280	0.47H	32H+B
H	L	L	H	H	L	L	L	H	L	H	×	281	0.41H	31H+B
L	H	L	H	H	L	L	L	H	L	H	×	282	0.36H	30H+B
H	H	L	H	H	L	L	L	H	L	H	×	283	0.32H	29H+B
L	L	H	H	H	L	L	L	H	L	H	×	284	0.28H	28H+B
H	L	H	H	H	L	L	L	H	L	H	×	285	0.24H	27H+B
L	H	H	H	H	L	L	L	H	L	H	×	286	0.22H	26H+B
H	H	H	H	H	L	L	L	H	L	H	×	287	0.20H	25H+B
L	L	L	L	L	H	L	L	H	L	H	×	288	0.17H	24H+B
H	L	L	L	L	H	L	L	H	L	H	×	289	INHIBIT	23H+B
L	H	L	L	L	H	L	L	H	L	H	×	290	INHIBIT	22H+B
H	H	L	L	L	H	L	L	H	L	H	×	291	INHIBIT	21H+B
L	L	H	L	L	H	L	L	H	L	H	×	292	INHIBIT	20H+B
H	L	H	L	L	H	L	L	H	L	H	×	293	INHIBIT	19H+B
L	H	H	L	L	H	L	L	H	L	H	×	294	INHIBIT	18H+B
H	H	H	L	L	H	L	L	H	L	H	×	295	INHIBIT	17H+B
L	L	L	H	L	H	L	L	H	L	H	×	296	INHIBIT	16H+B
H	L	L	H	L	H	L	L	H	L	H	×	297	INHIBIT	15H+B
L	H	L	H	L	H	L	L	H	L	H	×	298	INHIBIT	14H+B

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Serial Data												n	Exposure Period(H)	
D0	D1	D2	D3	D4	D5	D6	D7	D8	SMD1	SMD2	dummy		NTSC	PAL
H	H	L	H	L	H	L	L	H	L	H	×	299	INHIBIT	13H+B
L	L	H	H	L	H	L	L	H	L	H	×	300	INHIBIT	12H+B
H	L	H	H	L	H	L	L	H	L	H	×	301	INHIBIT	11H+B
L	H	H	H	L	H	L	L	H	L	H	×	302	INHIBIT	10H+B
H	H	H	H	L	H	L	L	H	L	H	×	303	INHIBIT	9H+B
L	L	L	L	H	H	L	L	H	L	H	×	304	INHIBIT	8H+B
H	L	L	L	H	H	L	L	H	L	H	×	305	INHIBIT	7H+B
L	H	L	L	H	H	L	L	H	L	H	×	306	INHIBIT	6.85H
H	H	L	L	H	H	L	L	H	L	H	×	307	INHIBIT	6H+B
L	L	H	L	H	H	L	L	H	L	H	×	308	INHIBIT	5.85H
H	L	H	L	H	H	L	L	H	L	H	×	309	INHIBIT	5H+B
L	H	H	L	H	H	L	L	H	L	H	×	310	INHIBIT	4.85H
H	H	H	L	H	H	L	L	H	L	H	×	311	INHIBIT	4H+B
L	L	L	H	H	H	L	L	H	L	H	×	312	INHIBIT	4.06H
H	L	L	H	H	H	L	L	H	L	H	×	313	INHIBIT	3.67H
L	H	L	H	H	H	L	L	H	L	H	×	314	INHIBIT	3H+B
H	H	L	H	H	H	L	L	H	L	H	×	315	INHIBIT	3.06H
L	L	H	H	H	H	L	L	H	L	H	×	316	INHIBIT	2.67H
H	L	H	H	H	H	L	L	H	L	H	×	317	INHIBIT	2H+B
L	H	H	H	H	H	L	L	H	L	H	×	318	INHIBIT	2.16H
H	H	H	H	H	H	L	L	H	L	H	×	319	INHIBIT	1.95H
L	L	L	L	L	L	H	L	H	L	H	×	320	INHIBIT	1.74H
H	L	L	L	L	L	H	L	H	L	H	×	321	INHIBIT	1.55H
L	H	L	L	L	L	H	L	H	L	H	×	322	INHIBIT	1H+B
H	H	L	L	L	L	H	L	H	L	H	×	323	INHIBIT	1.20H
L	L	H	L	L	L	H	L	H	L	H	×	324	INHIBIT	1.05H
H	L	H	L	L	L	H	L	H	L	H	×	325	INHIBIT	0.92H
L	H	H	L	L	L	H	L	H	L	H	×	326	INHIBIT	0.80H
H	H	H	L	L	L	H	L	H	L	H	×	327	INHIBIT	0.70H
L	L	L	H	L	L	H	L	H	L	H	×	328	INHIBIT	0.61H
H	L	L	H	L	L	H	L	H	L	H	×	329	INHIBIT	0.53H
L	H	L	H	L	L	H	L	H	L	H	×	330	INHIBIT	0.47H
H	H	L	H	L	L	H	L	H	L	H	×	331	INHIBIT	0.41H
L	L	H	H	L	L	H	L	H	L	H	×	332	INHIBIT	0.36H
H	L	H	H	L	L	H	L	H	L	H	×	333	INHIBIT	0.32H
L	H	H	H	L	L	H	L	H	L	H	×	334	INHIBIT	0.28H
H	H	H	H	L	L	H	L	H	L	H	×	335	INHIBIT	0.25H
L	L	L	L	H	L	H	L	H	L	H	×	336	INHIBIT	0.22H
H	L	L	L	H	L	H	L	H	L	H	×	337	INHIBIT	0.10H
L	H	L	L	H	L	H	L	H	L	H	×	338	INHIBIT	0.17H
H	H	L	L	H	L	H	L	H	L	H	×	339	INHIBIT	INHIBIT
L	L	H	L	H	L	H	L	H	L	H	×	340	INHIBIT	INHIBIT
H	L	H	L	H	L	H	L	H	L	H	×	341	INHIBIT	INHIBIT
S	S	S	S	S	S	S	S	S	L	H	×	S	INHIBIT	INHIBIT
H	H	H	H	H	H	H	H	H	L	H	×	511	INHIBIT	INHIBIT

A = B = 0.37H

5. Electrical Characteristics

5-1. Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit
Supply voltage	V_{DD3}, V_{DD5}	-0.3 ~ 6.0	V
Input voltage	V_{I3}	-0.3 ~ $V_{DD3} + 0.3$	V
Input voltage	V_{I5}	-0.3 ~ $V_{DD5} + 0.3$	V
Output voltage	V_{O3}	-0.3 ~ $V_{DD3} + 0.3$	V
Output voltage	V_{O5}	-0.3 ~ $V_{DD5} + 0.3$	V
Operation temperature	T_{opr}	-20 ~ +70	°C
Storage temperature	T_{stg}	-55 ~ +150	°C

5-2. DC Characteristics

($V_{DD3}=+3.3V\pm10\%$, $V_{DD5}=+5V\pm10\%$, $T_{opr}=-20\sim+70^{\circ}C$)

Parameter	Symbol	Condition	MIN.	TYP.	MAX.	Unit	Note
Input "High" voltage	V_{IH3}		$0.7 \times V_{DD5}$			V	1, 2, 3
Input "Low" voltage	V_{IL3}				$0.3 \times V_{DD5}$	V	
Input "High" voltage	V_{IH5}		3.5			V	4, 5
Input "Low" voltage	V_{IL5}				1.5	V	
Input "High" current	I_{IH3-1}	$V_I = V_{DD3}$			1.0	μA	1
	I_{IH3-2}	$V_I = V_{DD3}$	3.0		30	μA	2
	I_{IH3-3}	$V_I = V_{DD3}$			2.0	μA	3
Input "Low" current	I_{IL3-1}	$V_I = 0V$			1.0	μA	1
	I_{IL3-2}	$V_I = 0V$			2.0	μA	2
	I_{IL3-3}	$V_I = 0V$	3.0		30	μA	3
Input "High" current	I_{IH5-1}	$V_I = V_{DD5}$			2.0	μA	4
	I_{IH5-2}	$V_I = V_{DD5}$	8.0		60	μA	5
Input "Low" current	I_{IL5-1}	$V_I = 0V$	8.0		60	μA	4
	I_{IL5-2}	$V_I = 0V$			2.0	μA	5
Output "High" voltage	V_{OH3-1}	$I_{OH} = 2mA$	$V_{DD3}-0.5$			V	6
Output "Low" voltage	V_{OL3-1}	$I_{OL} = 2mA$			0.4	V	
Output "High" voltage	V_{OH3-2}	$I_{OH} = -6mA$	$V_{DD3}-0.5$			V	7
Output "Low" voltage	V_{OL3-2}	$I_{OL} = 6mA$			0.4	V	
Output "High" voltage	V_{OH5-1}	$I_{OH} = -6mA$	$V_{DD5}-0.5$			V	8
Output "Low" voltage	V_{OL5-1}	$I_{OL} = 6mA$			0.4	V	
Output "High" voltage	V_{OH5-2}	$I_{OH} = -12mA$	$V_{DD5}-0.5$			V	9
Output "Low" voltage	V_{OL5-2}	$I_{OL} = 12mA$			0.4	V	

Note1 : Applied to Inputs (IC3, OSCI3)

Note2 : Applied to Input (ICD3).

Note3 : Applied to Input (ICU3).

Note4 : Applied to Input (ICU5).

Note5 : Applied to Input (ICD5).

Note6 : Applied to Output (OSC03).

(Output(OSC03) measures on conditions that input(OSCI3) level is 0V or V_{DD3} .)

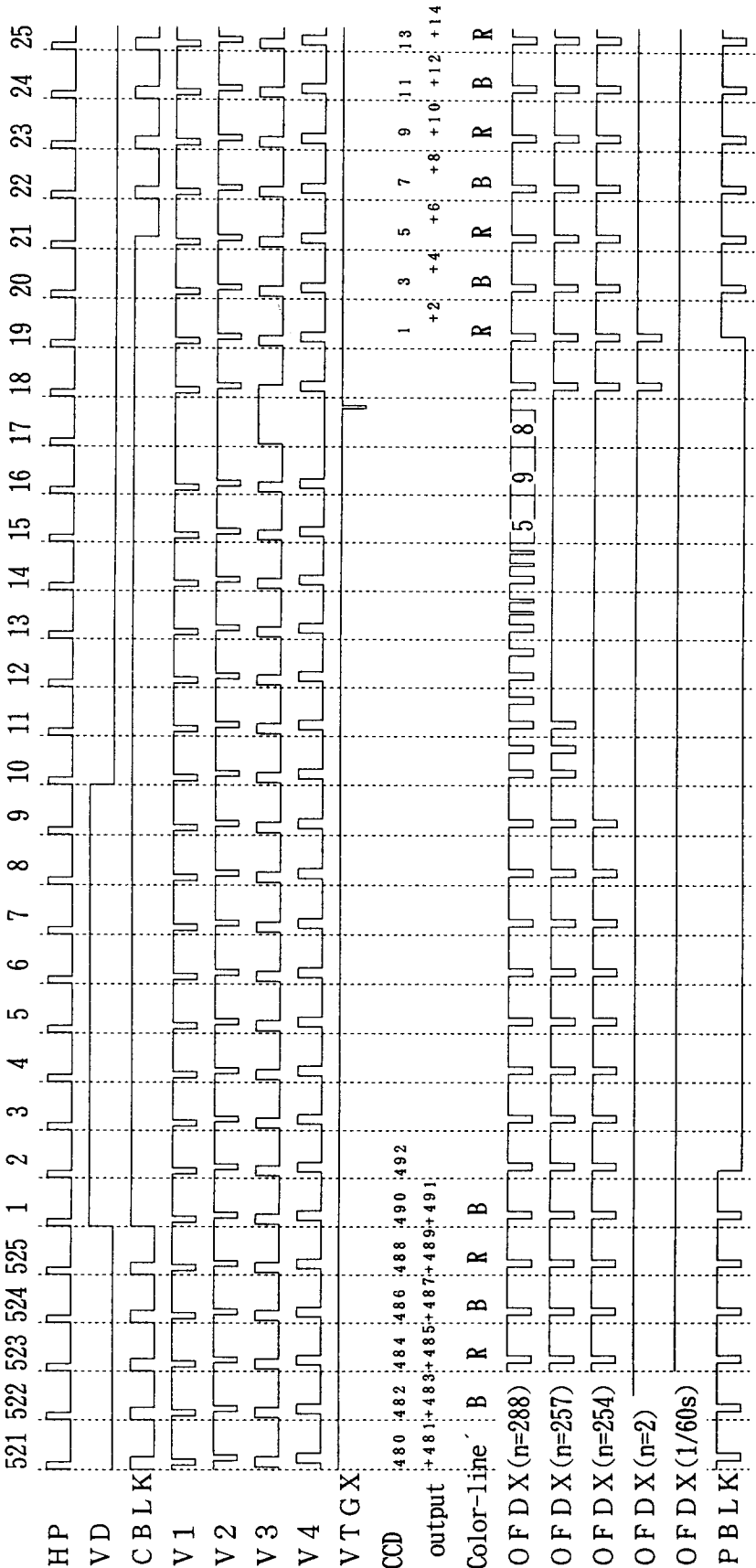
Note7 : Applied to Output(O6MA32).

Note8 : Applied to Output(O6MA5).

Note9 : Applied to Output(O6MA52).

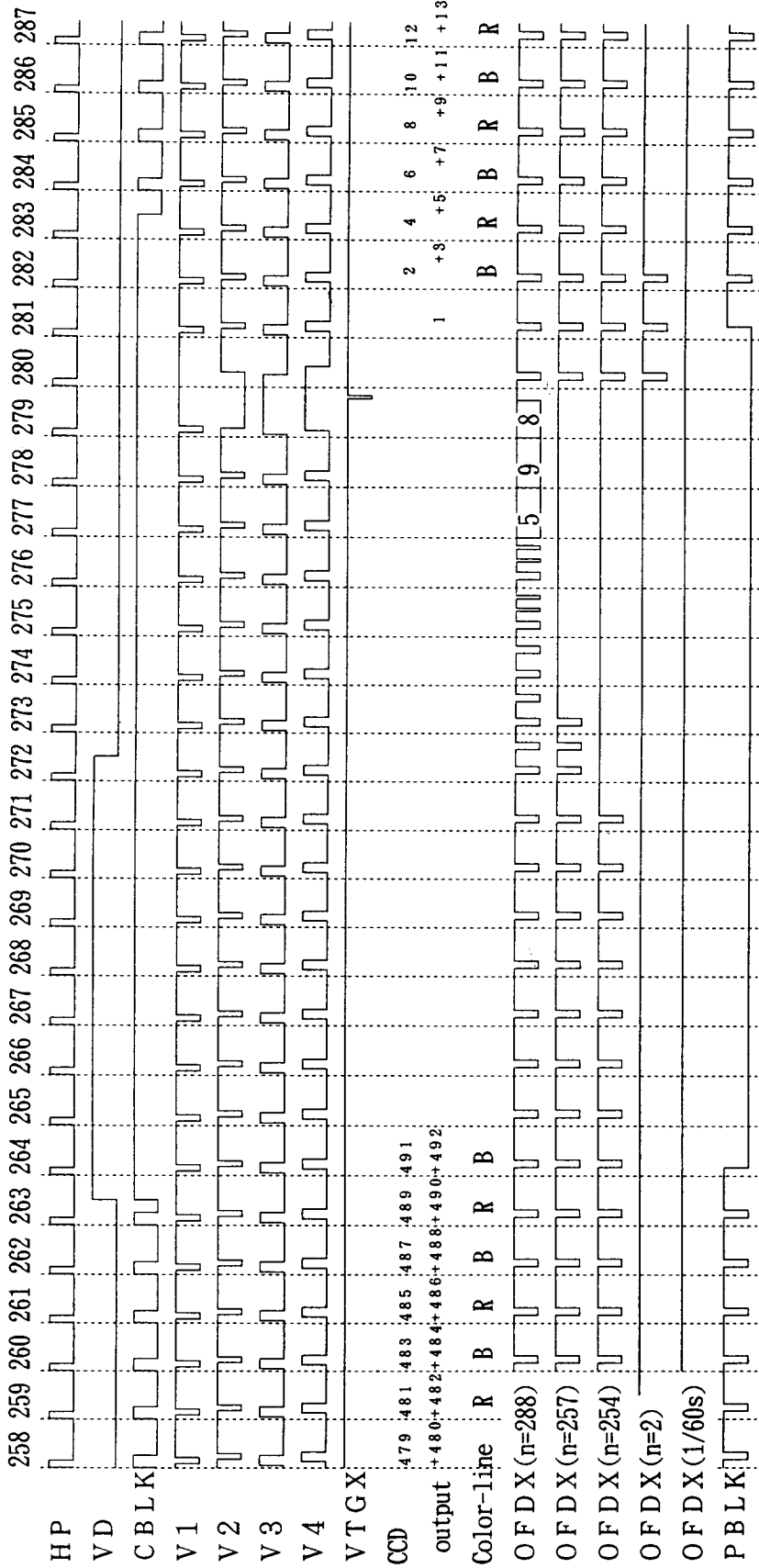
6. Pulse Timing
6-1. Vertical pulse for driving CCD - 1 for 270K CCD

NTSC (1)
Normal mode



Vertical pulse for driving CCD - 2 for 270K CCD

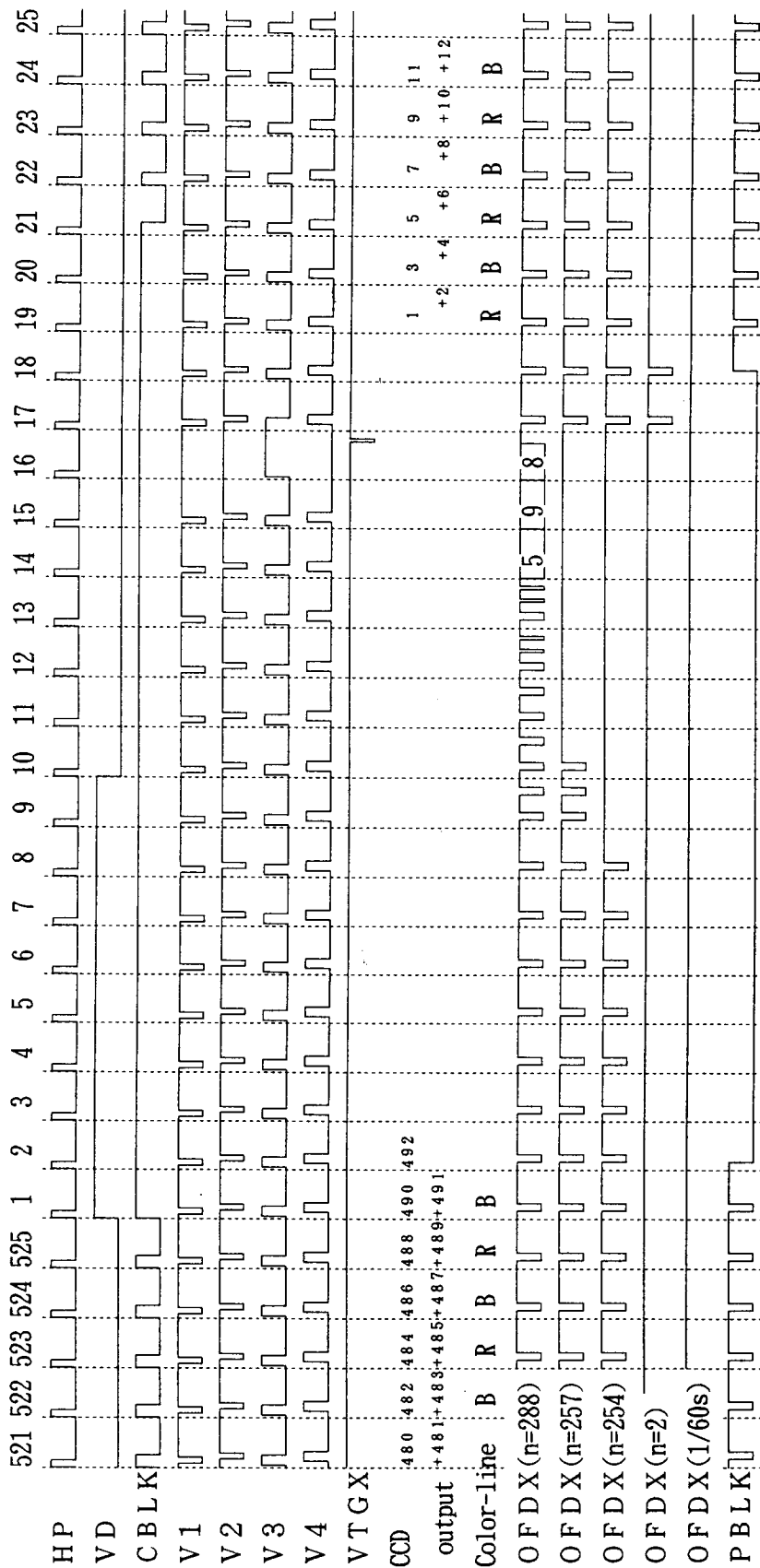
NTSC (2)
Normal mode



Vertical pulse for driving CCD - 3

NTSC (3)

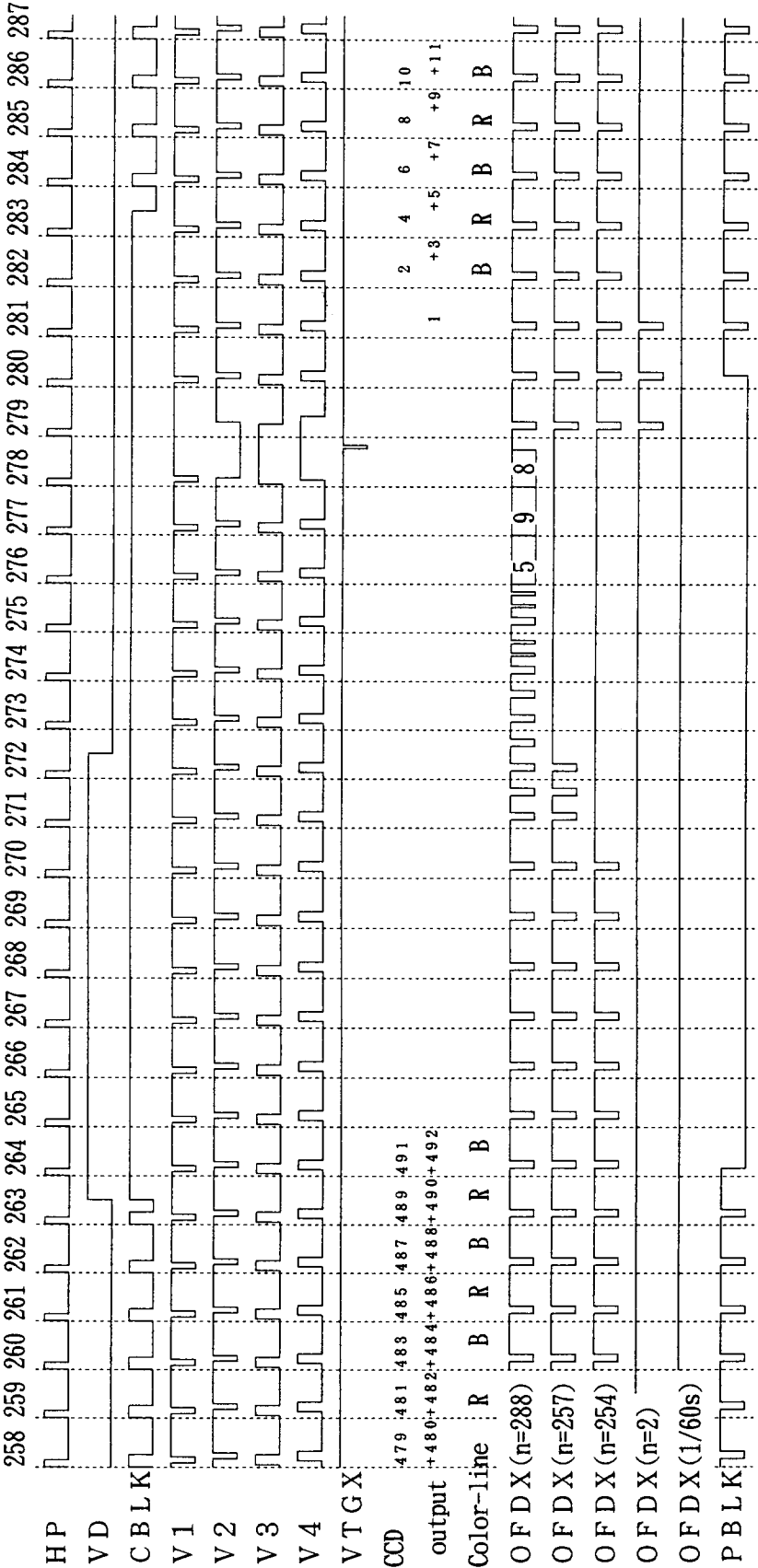
Mirror mode



Vertical pulse for driving CCD for 270K CCD

NTSC (4)

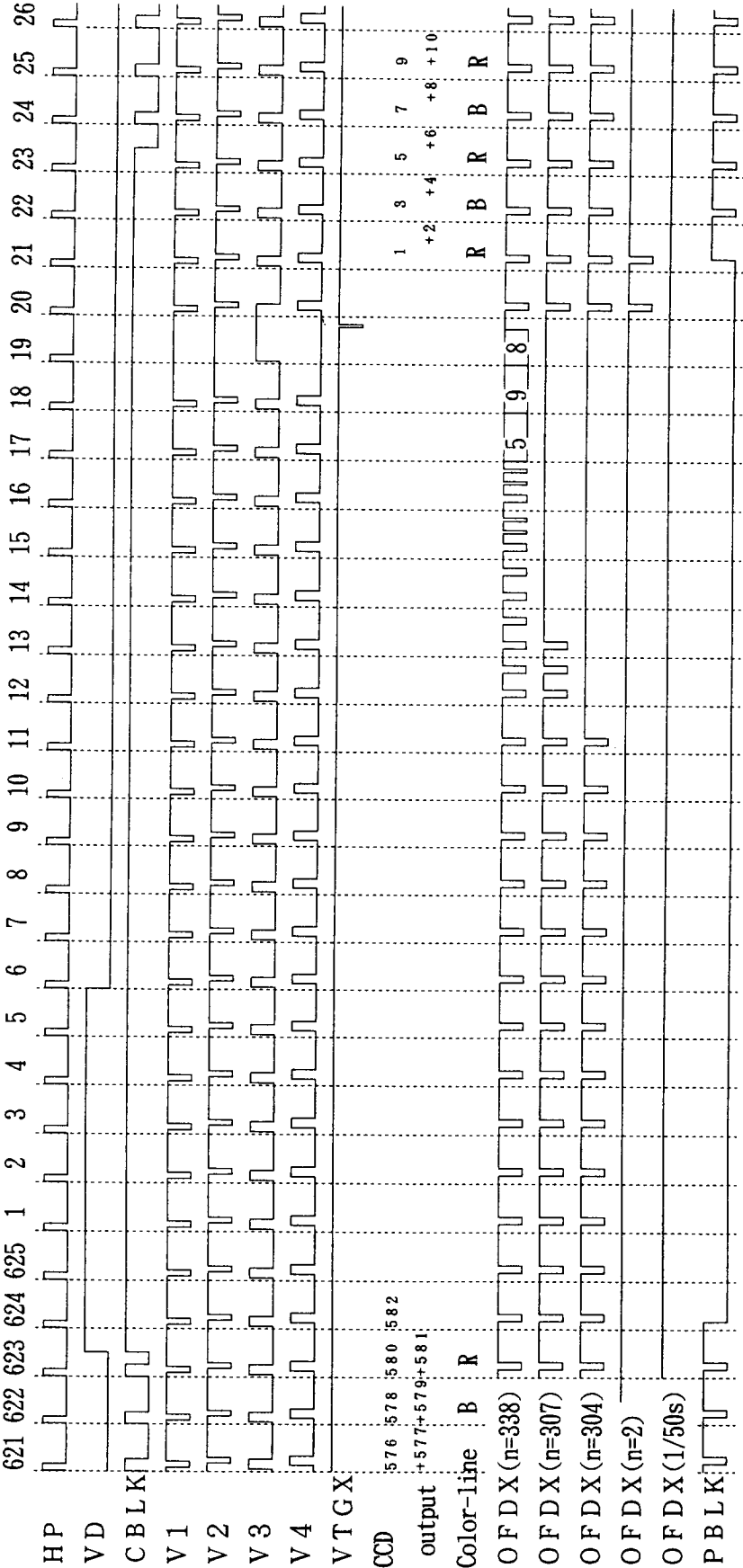
Mirror mode



Vertical pulse for driving CCD - 5 for 320K CCD

PAL (1)

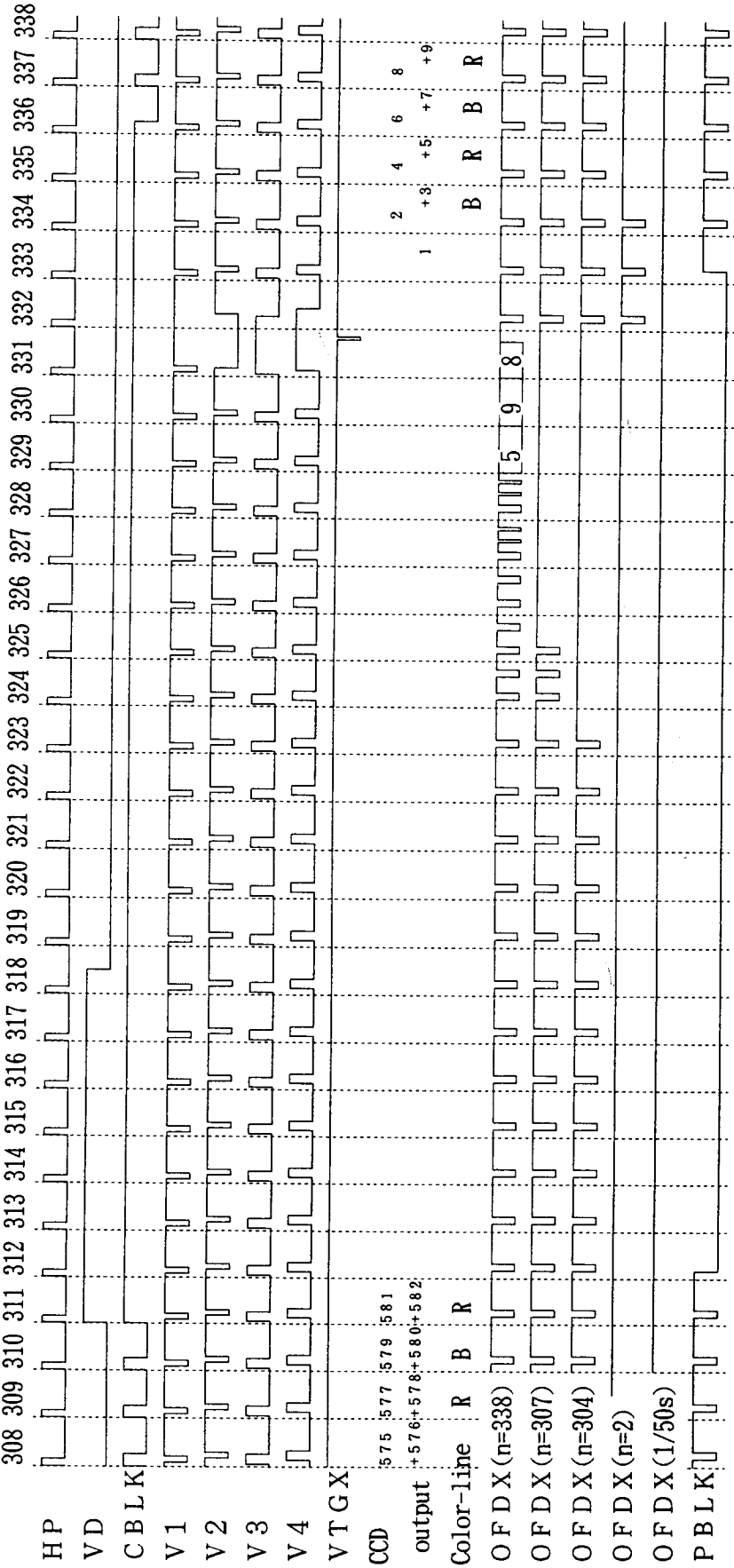
Normal mode



Vertical pulse for driving CCD - 6 for 320K CCD

PAL (2)

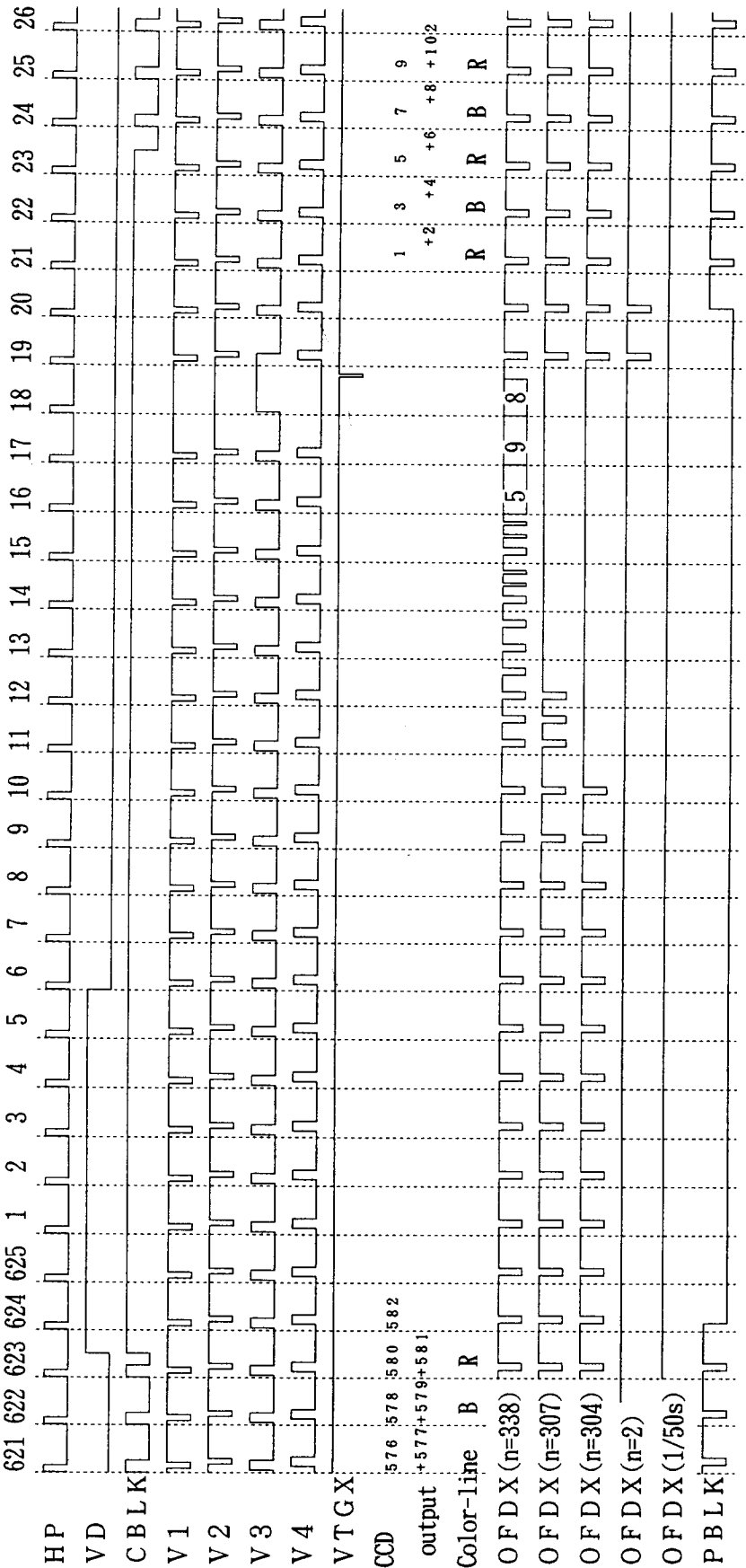
Normal mode



Vertical pulse for driving CCD - 7 for 320K CCD

PAL (3)

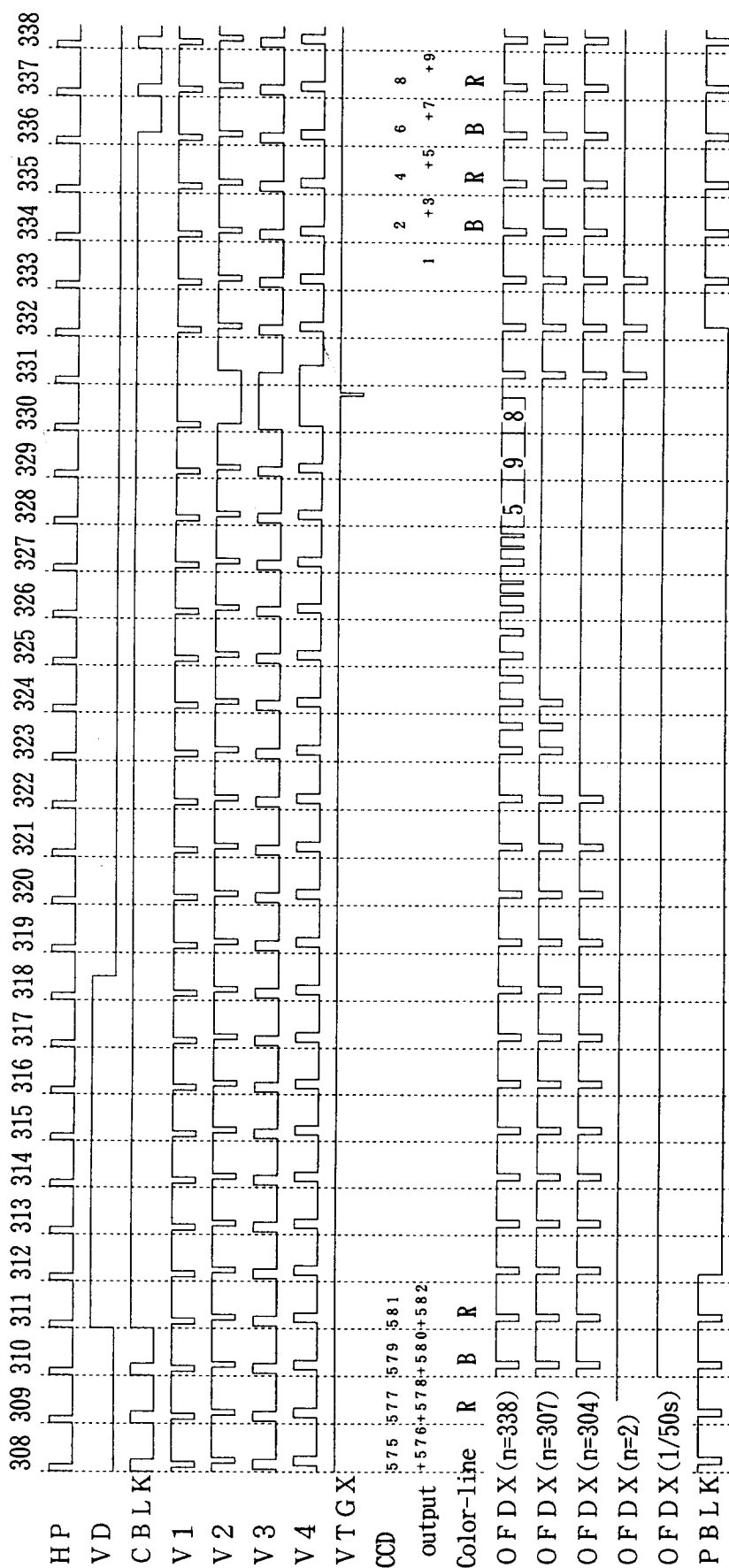
Mirror mode



for 320K CCD

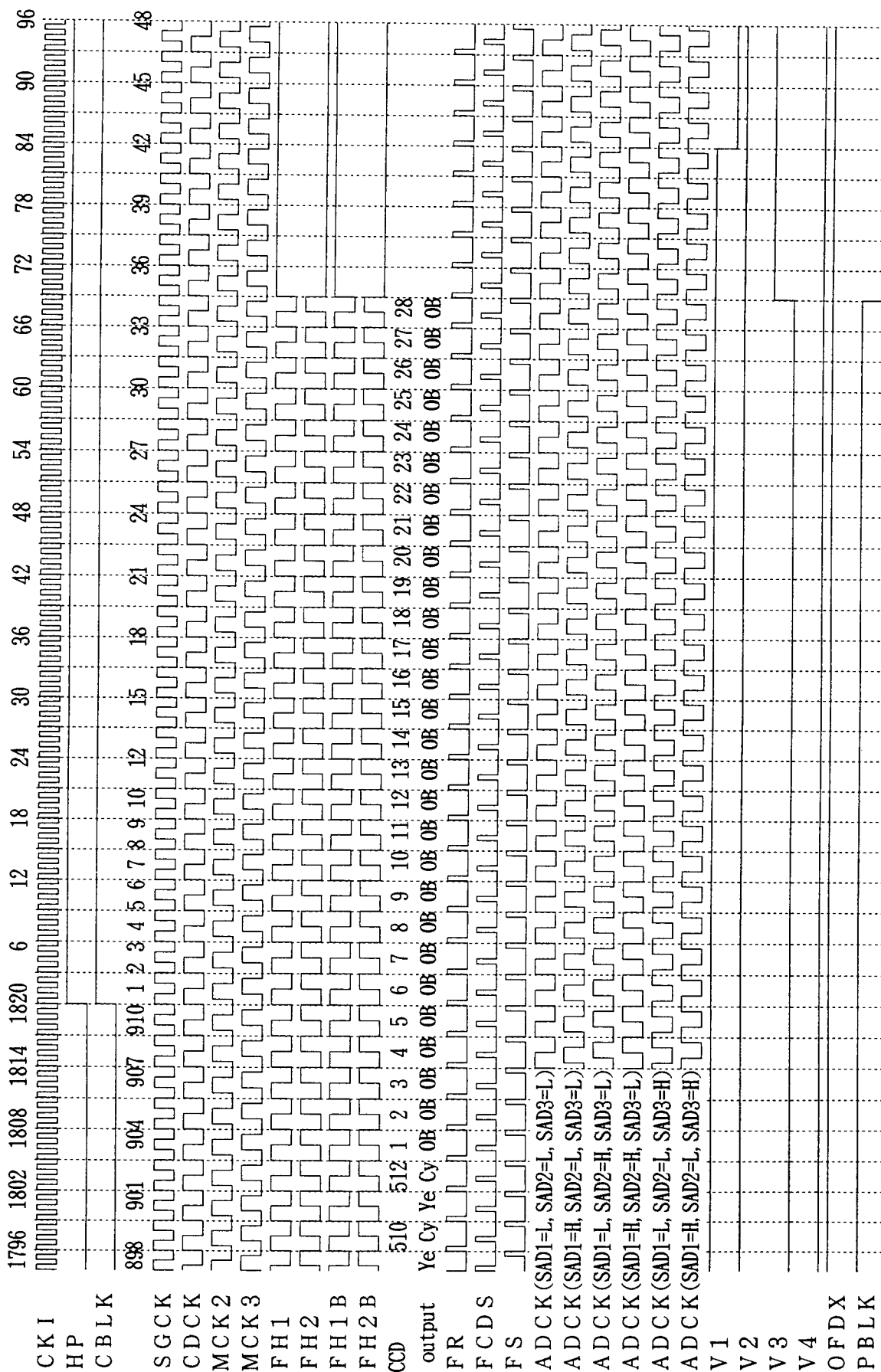
PAL (4)

Mirror mode



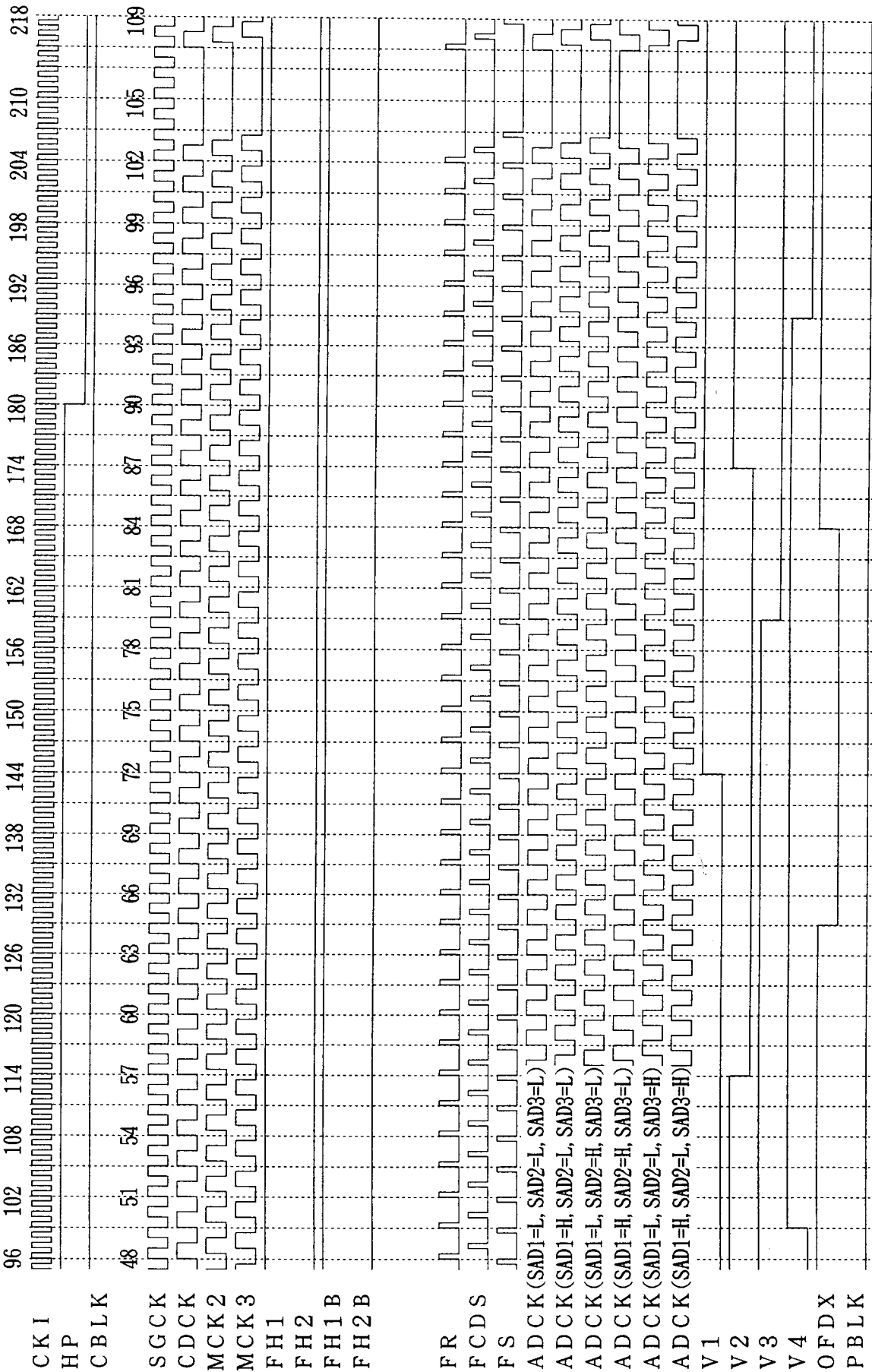
6-2. Horizontal pulse for driving CCD - 1

NTSC	Normal mode
1	1
2	2
3	3
4	4
5	5
6	6
7	7
8	8
9	9
10	10
11	11
12	12
13	13
14	14
15	15
16	16
17	17
18	18
19	19
20	20
21	21
22	22
23	23
24	24
25	25
26	26
27	27
28	28
29	29
30	30
31	31
32	32
33	33
34	34
35	35
36	36
37	37
38	38
39	39
40	40
41	41
42	42
43	43
44	44
45	45
46	46
47	47
48	48
49	49
50	50
51	51
52	52
53	53
54	54
55	55
56	56
57	57
58	58
59	59
60	60
61	61
62	62
63	63
64	64
65	65
66	66
67	67
68	68
69	69
70	70
71	71
72	72
73	73
74	74
75	75
76	76
77	77
78	78
79	79
80	80
81	81
82	82
83	83
84	84
85	85
86	86
87	87
88	88
89	89
90	90
91	91
92	92
93	93
94	94
95	95
96	96
97	97
98	98
99	99
100	100



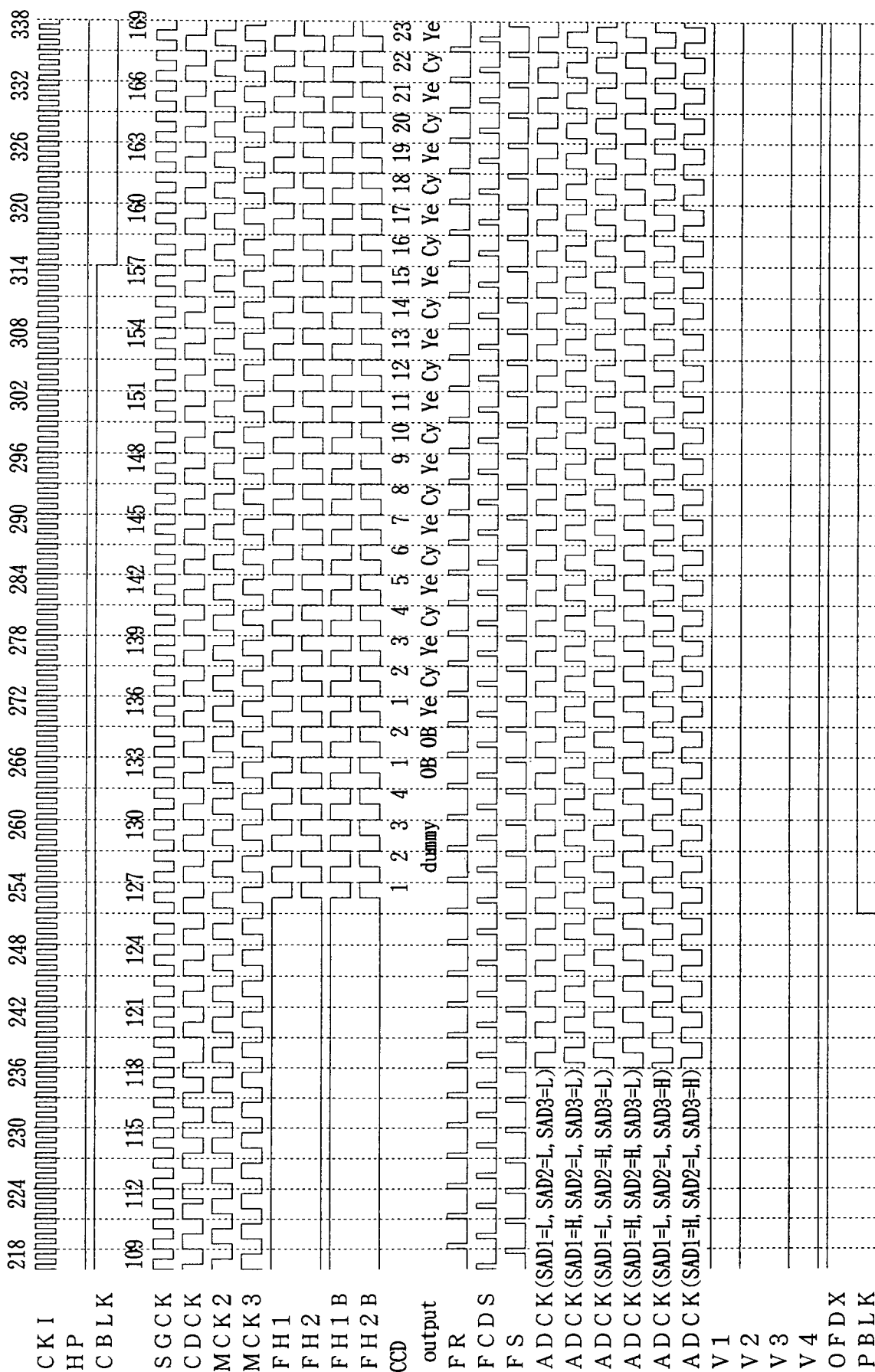
Horizontal pulse for driving CCD - 2

NTSC Normal mode



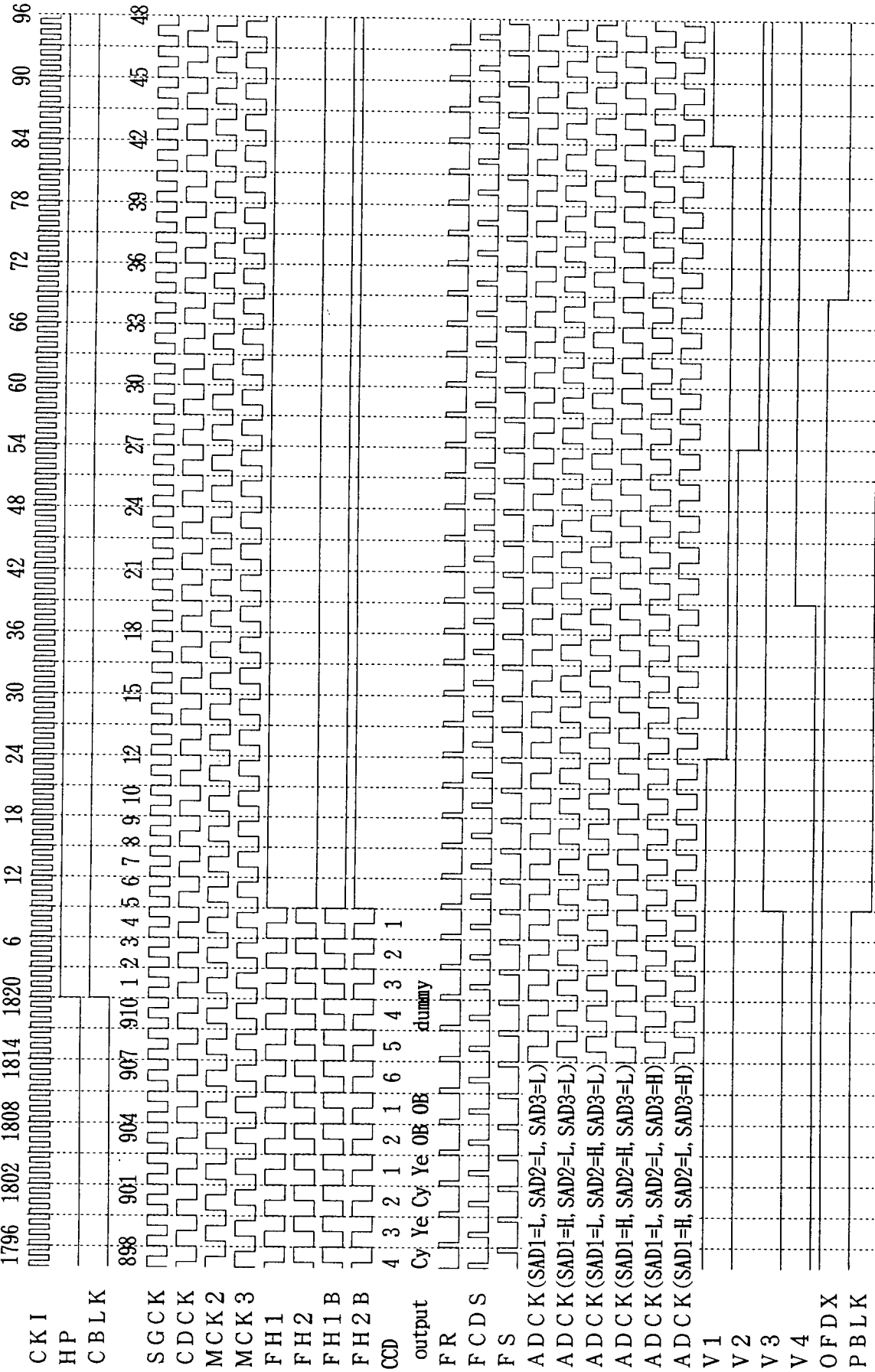
Horizontal pulse for driving CCD - 3

NTSC Normal mode



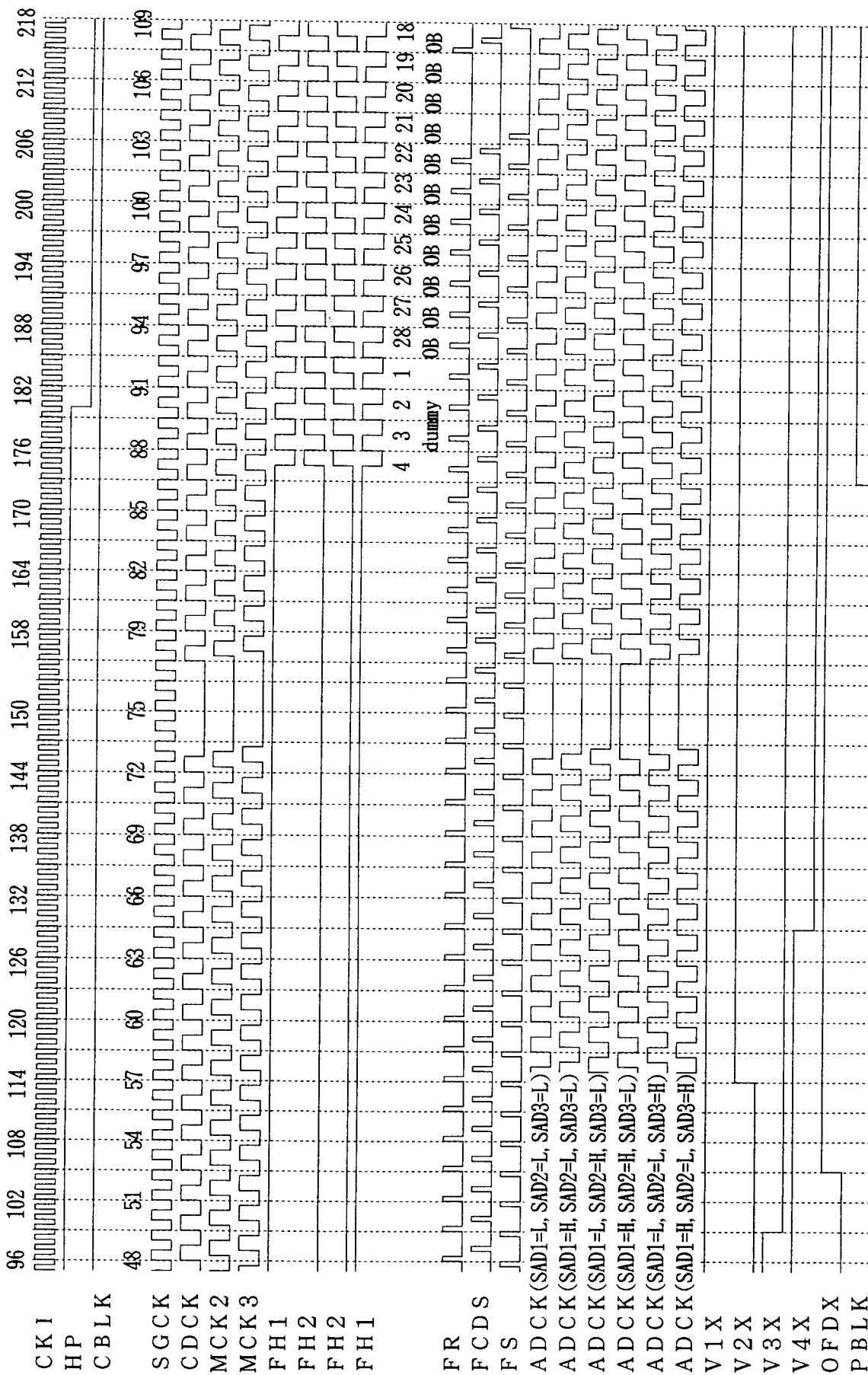
Horizontal pulse for driving CCD - 4

NTSC Mirror mode



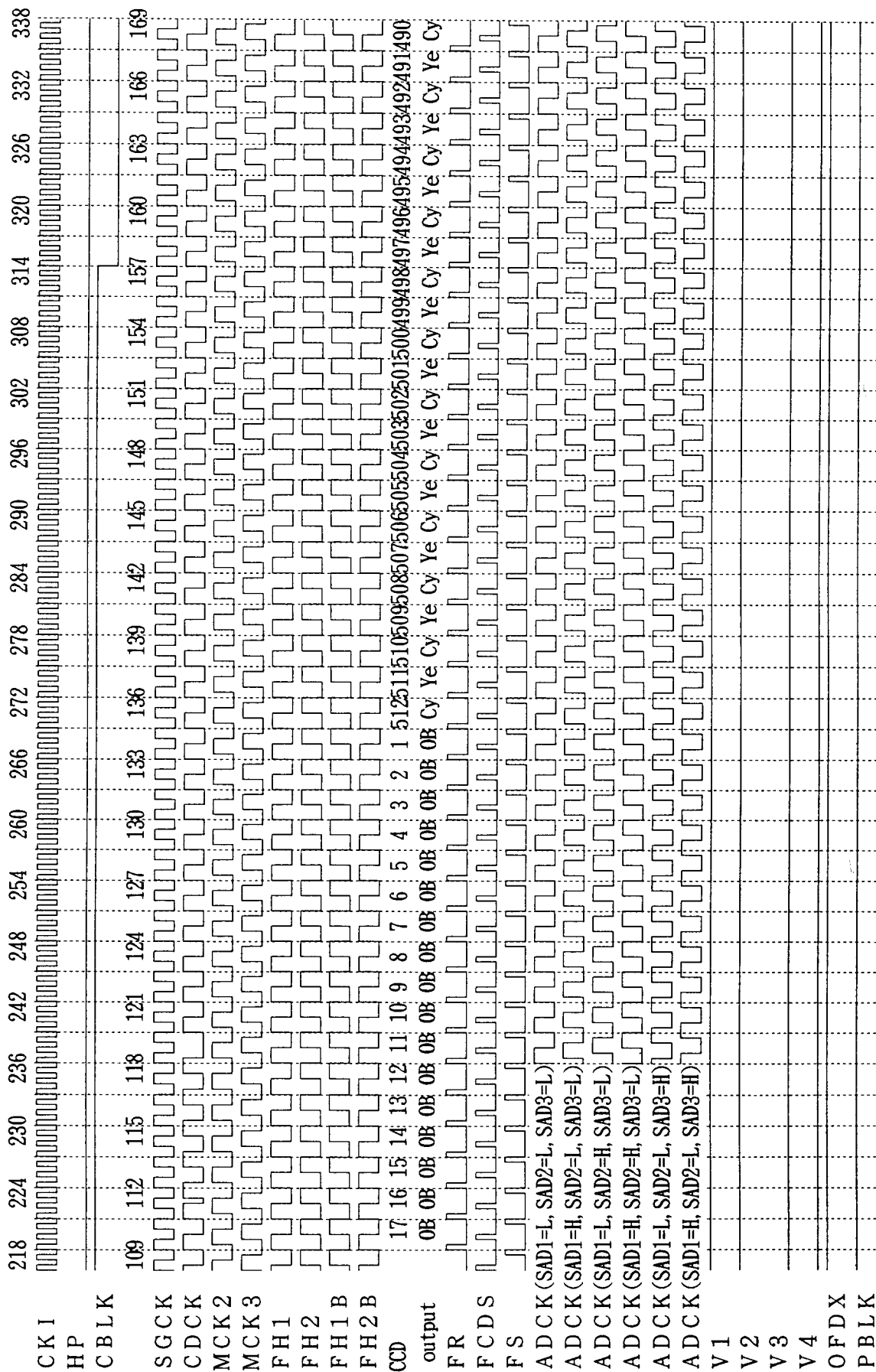
Horizontal pulse for driving CCD - 5

NTSC Mirror mode



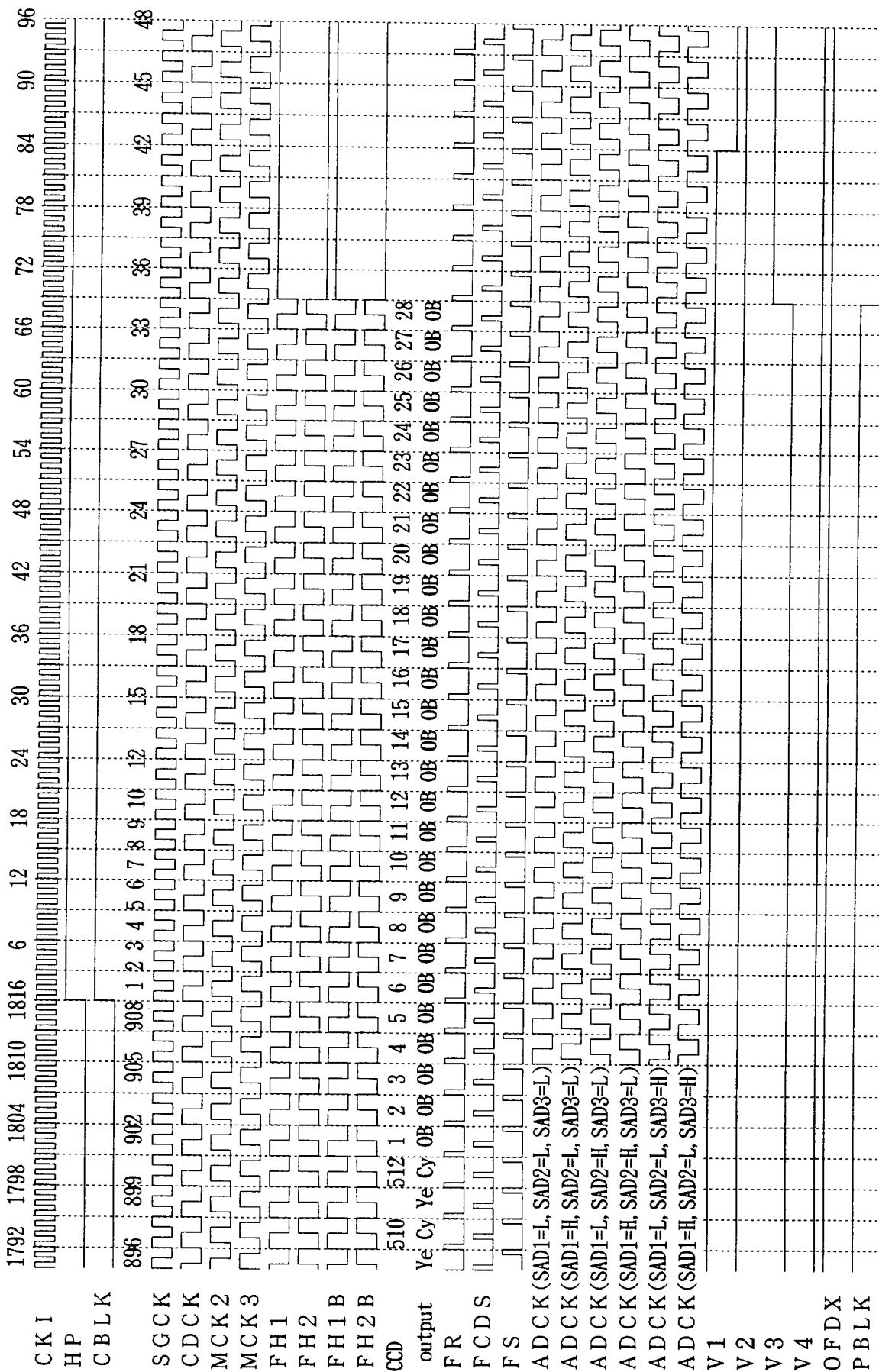
Horizontal pulse for driving CCD - 6

NTSC Mirror mode



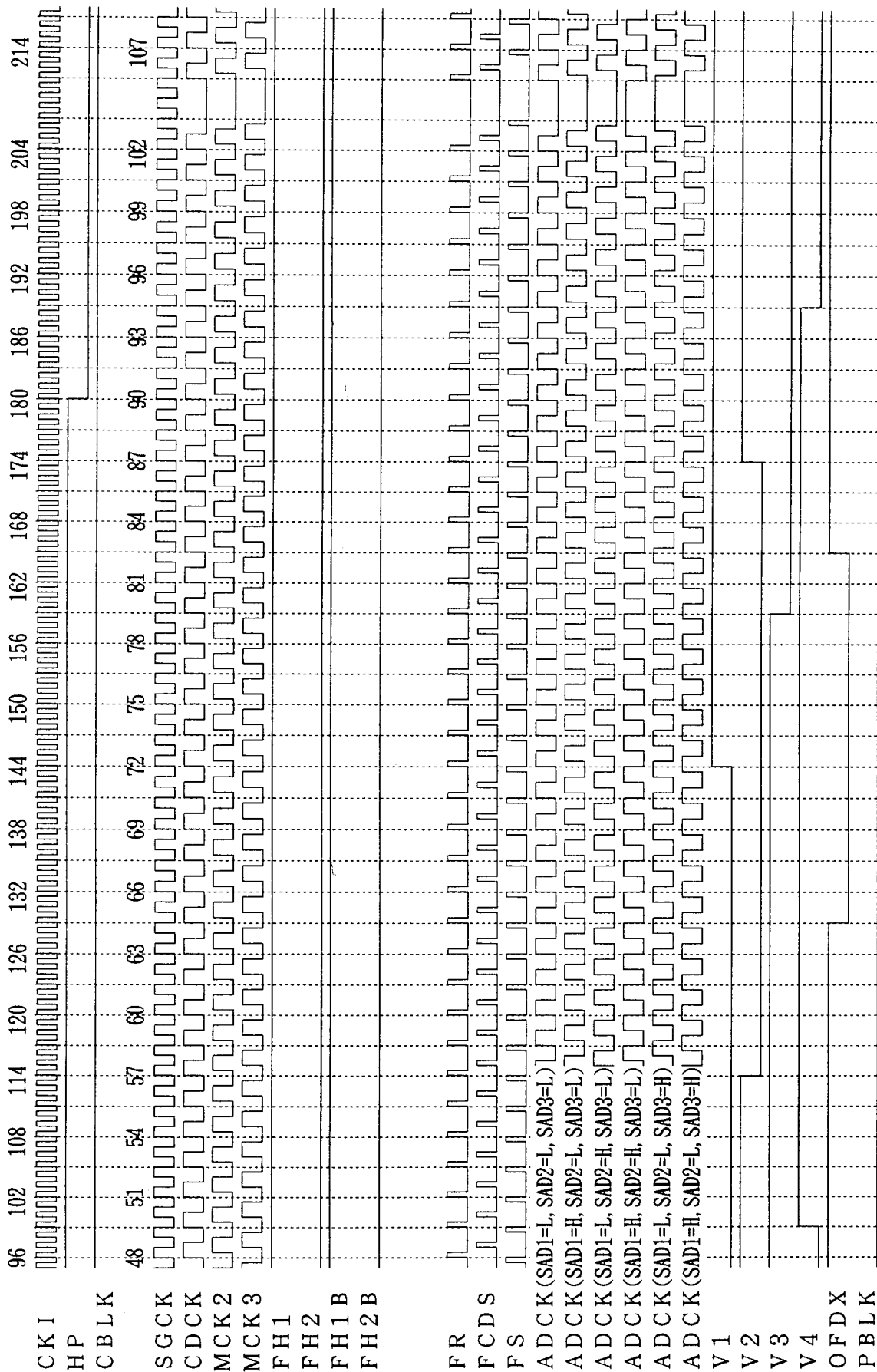
Horizontal pulse for driving CCD - 7

P A L normal mode



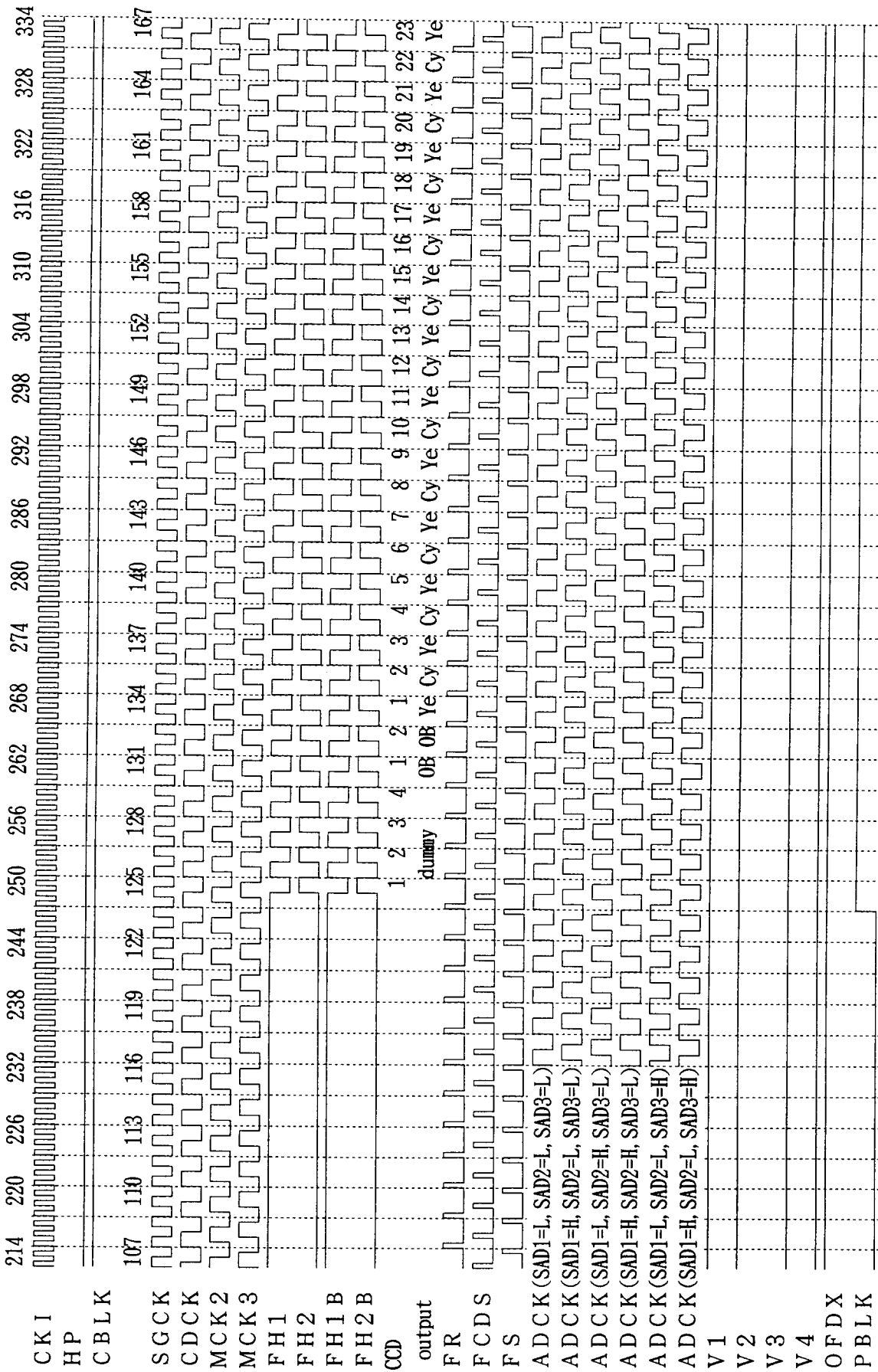
Horizontal pulse for driving CCD - 8

PAL Normal mode



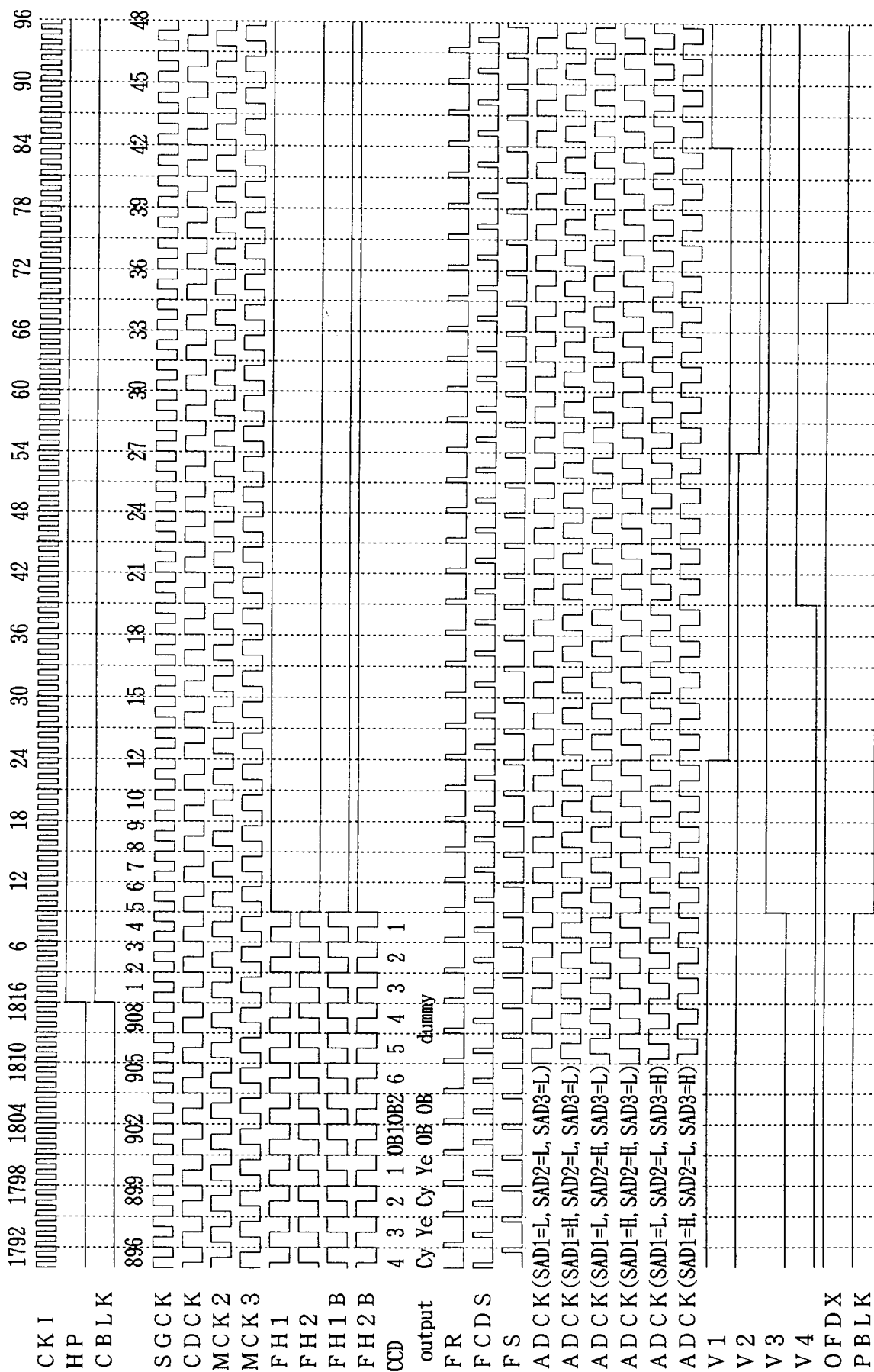
Horizontal pulse for driving CCD - 9

PAL Normal mode



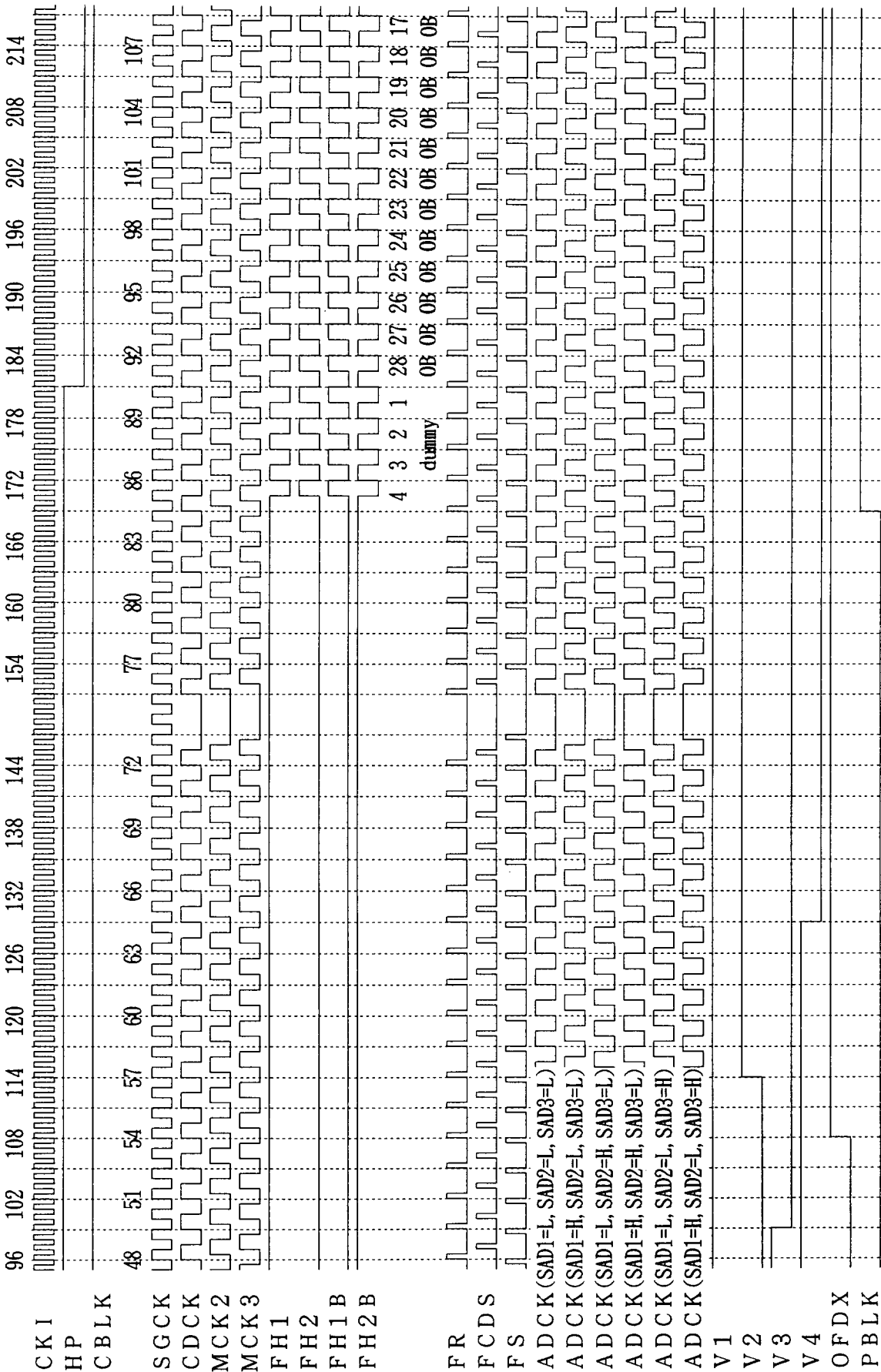
Horizontal pulse for driving CCD - 10

PAL Mirror mode



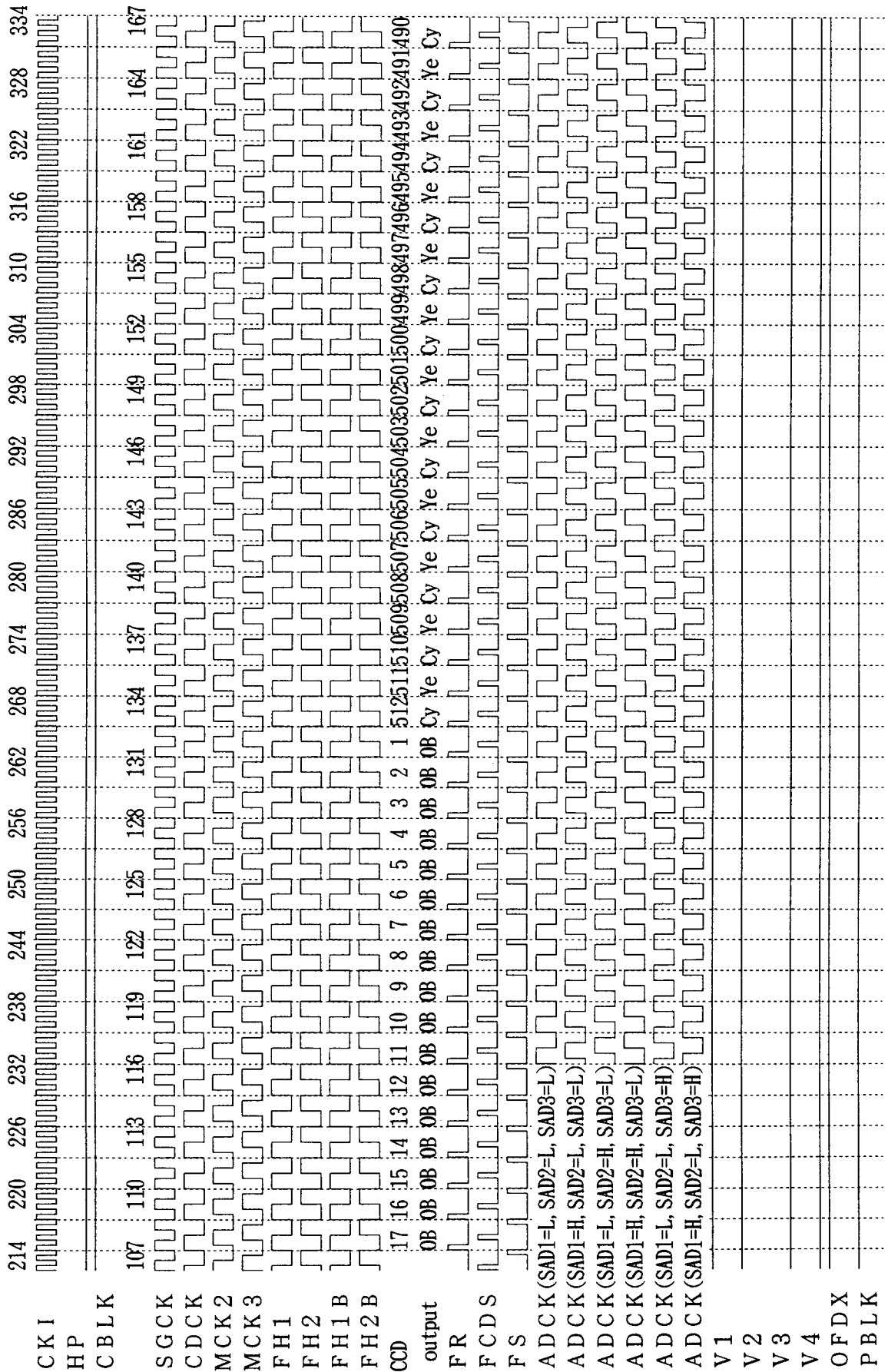
Horizontal pulse for driving CCD - 1 1

PAL Mirror mode



Horizontal pulse for driving CCD -- 1 2

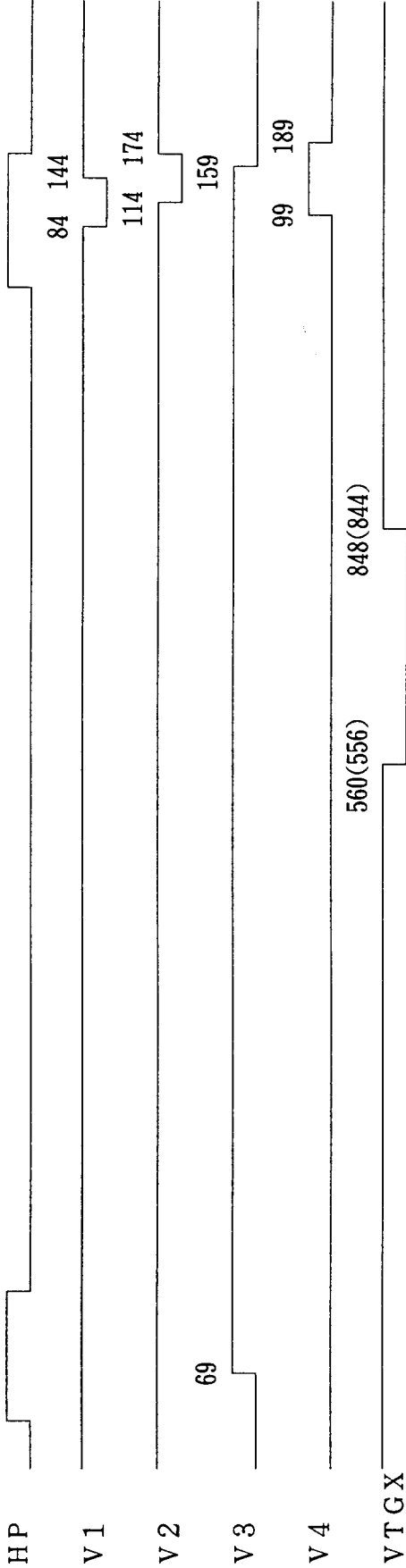
PAL Mirror mode



6-3. Read out pulse - 1 Normal mode

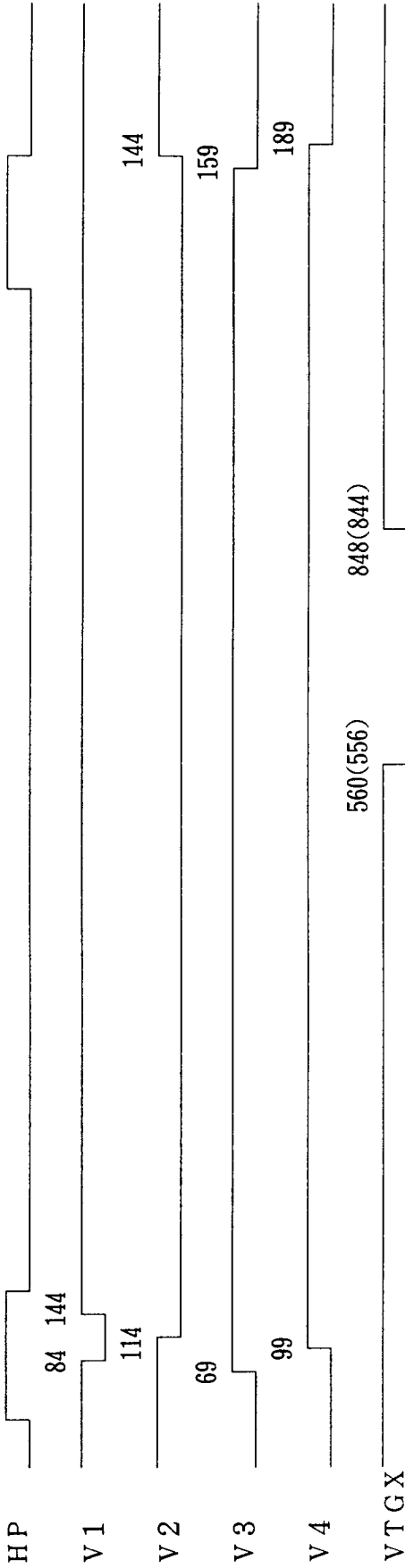
ODD (1, 3) Field

1ck=34.92(35.24)ns, () : PAL
0 180 1820(1816) 180



EVEN (2, 4) Field

0 180 1820(1816) 180



LR38277

Read out pulse - 2 Morror mode

ODD(1, 3) Field

1ck=34.92(35.24)ns, () ;PAL

0 180

1820(1816) 180

HP

V1

24 84

V2

54 114

V3

9

99

V4

39 129

VTGX

500(496)

788(784)

EVEN (2, 4) Field

0 180

1820(1816) 180

HP

V1

24 84

V2

54

114

V3

9

99

V4

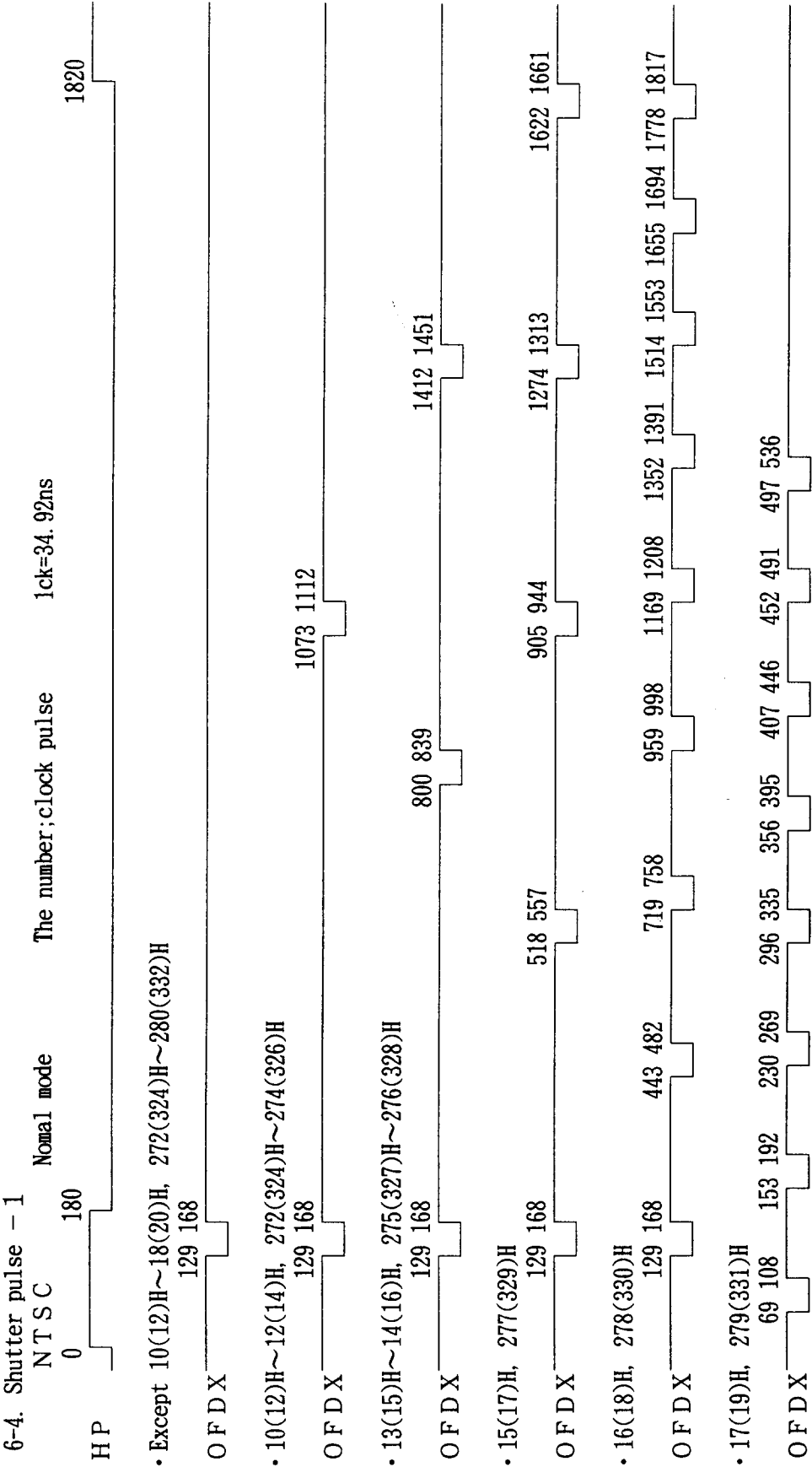
39

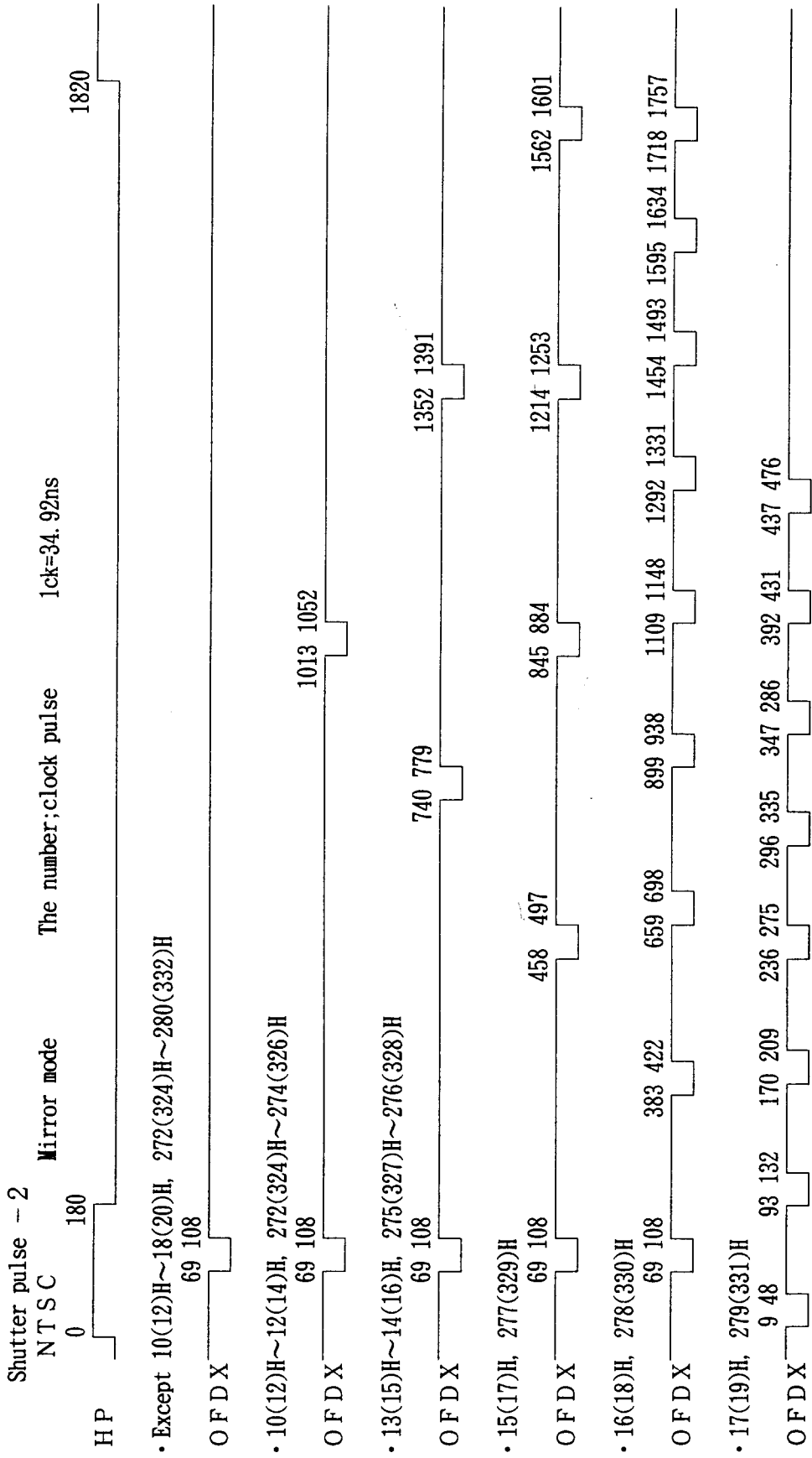
129

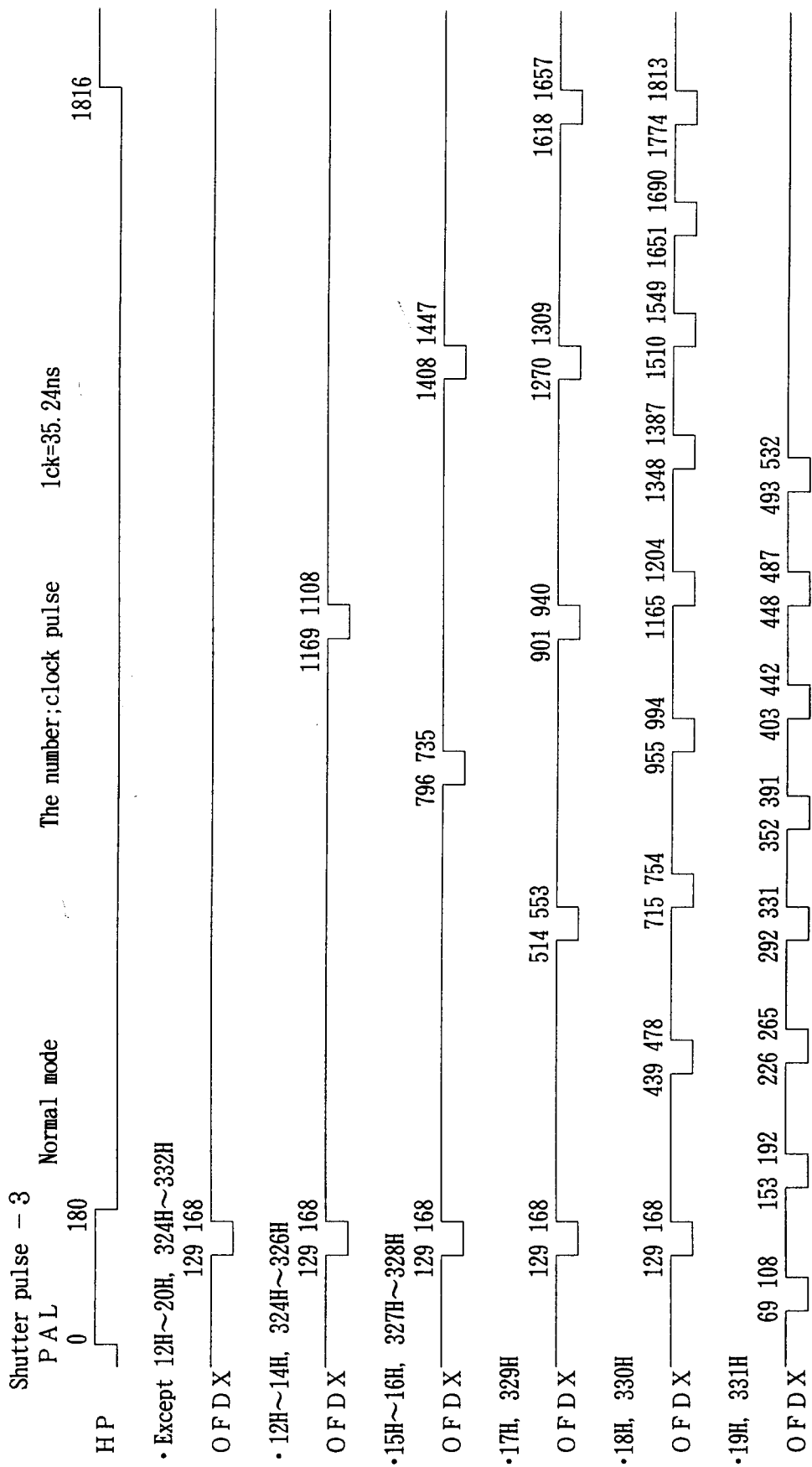
VTGX

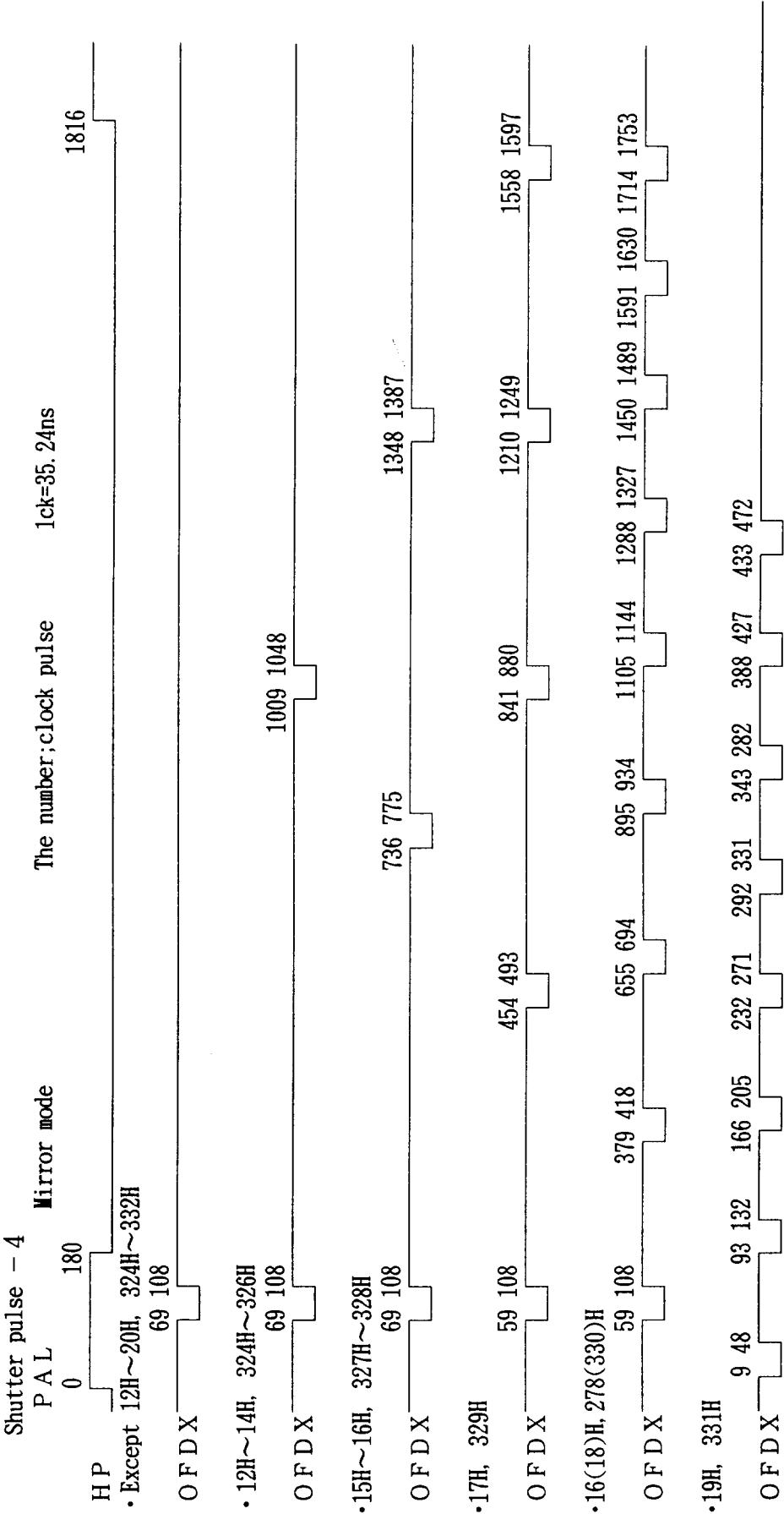
500(496)

788(784)









7 Package and packing specification

1. Package Outline Specification

Refer to drawing No. AA1035

2. Markings

2-1. Marking contents

(1) Product name : LR38277

(2) Company name : SHARP

(3) Date code

(Example) YY WW X

Indicates the product was manufactured in the WWth week of 19YY.

Denotes the production ref. code.

Denotes the production week. (01, 02, 03, 52, 53)

Denotes the production year. (Lower two digits of the year.)

(4) The marking of "JAPAN" indicates the country of origin.

2-2. Marking layout

Refer to drawing No. AA1035

(This layout do not define the dimensions of marking character and marking position.)

3. Packing Specification

3-1. Packing materials

Material Name	Material Specification	Purpose
Tray	Conductive plastic (80devices/tray)	Fixing of device
Upper cover tray	Conductive plastic (1tray/case)	Fixing of device
Laminated aluminum bag	Aluminum polyethylene (1bag/case)	Drying of device
Desiccant	Silica gel	Drying of device
P P band	Polypropylene (3 pcs/case)	Device tray fixing
Inner case	Card board (800devices/case)	Packaging of device
Label	Paper	Indicates part number, quantity and date of manufacture
Outer case	Cardboard	Outer packing of device case

(Devices shall be placed into a tray in the same direction.)

3-2. Outline dimension of tray

Refer to attached drawing

4. Precaution For Unpacking

- (1) Unpacking should be done on the stand as well as human body treated with anti-ESD.
- (2) Conductive treatment or anti-ESD treatment is given to a dray. Use the equivalent tray, if it is changed to another one.

5. Surface Mount Conditions

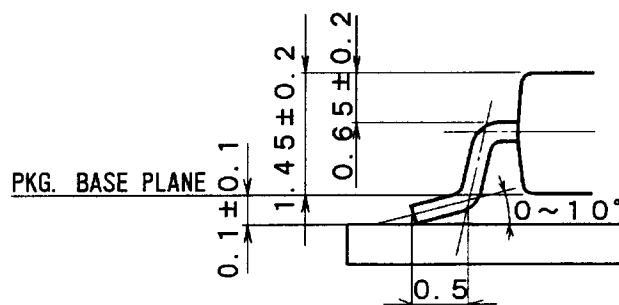
Please perform the following conditions when mounting ICs not to deteriorate IC quality.

5-1. Soldering conditions (The following conditions are valid only for one time soldering.)

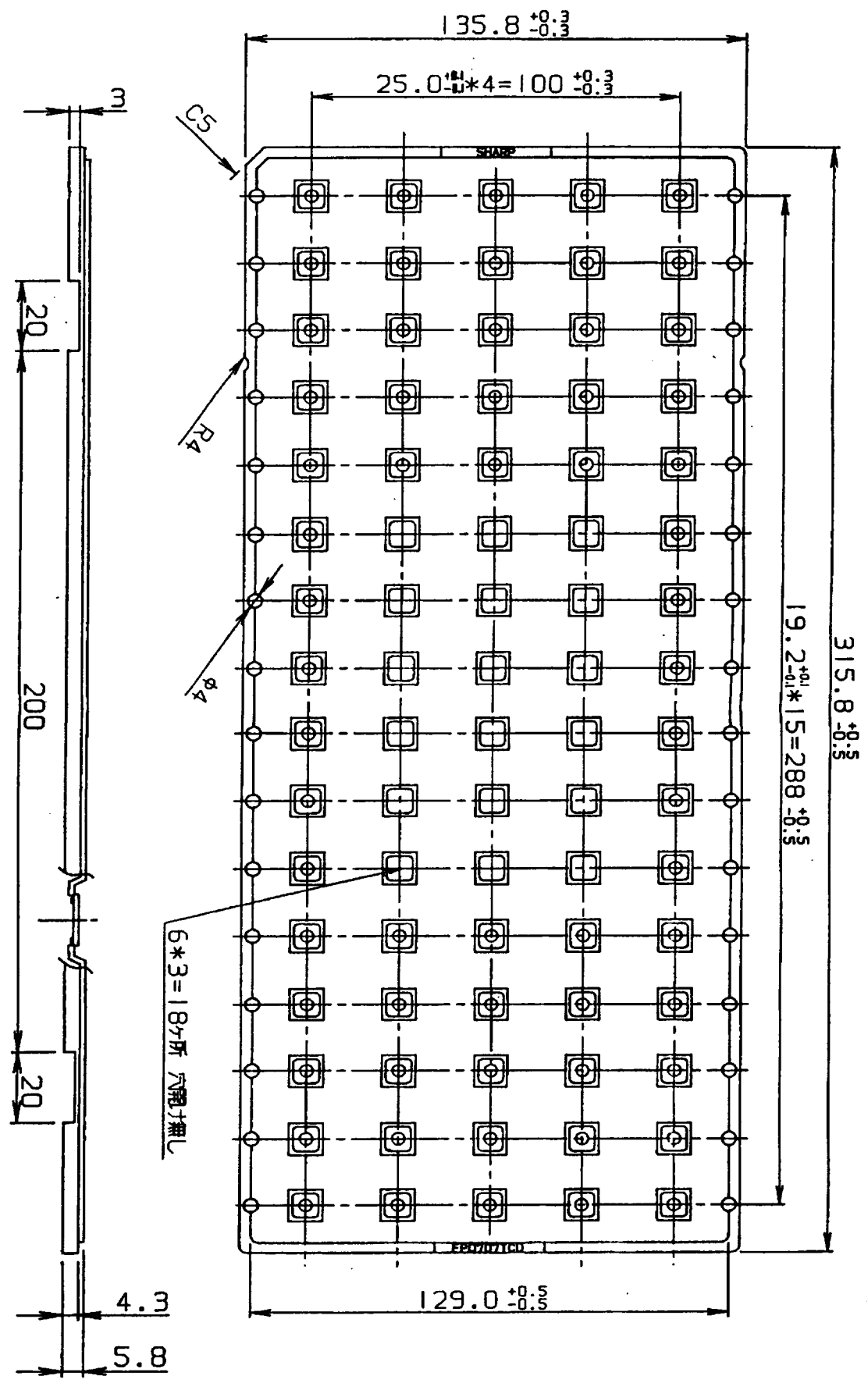
Mounting Method	Temperature and Duration	Measurement Point
Reflow soldering (air)	Peak temperature of 240°C, duration less than 15 seconds above 230°C, temperature increase rate of 1~4°C/second	IC surface
Vapor phase soldering	215°C or less, duration less than 40 seconds above 200°C	Steam
Manual soldering (soldering iron)	260°C or less, duration less than 10 seconds	IC outer lead surface

5-2. Conditions for removal of residual flux

- (1) Ultrasonic washing power : 25 Watts/liter or less
- (2) Washing time : Total 1 minute maximum
- (3) Solvent temperature : 15~40°C



名称 NAME	QFP48-P-0707	リード仕上 LEAD FINISH	TIN-LEAD PLATING	備考 NOTE	プラスチックパッケージ外形寸法は、バリを含まないものとする。 Plastic body dimensions do not include burr of resin.
DRAWING NO.	AA1035	単位 UNIT	mm		



名称 NAME		FP0707TCD		備考 NOTE
DRAWING NO.	CV536	単位 UNIT	mm	